IEI Integration Corp.

MODEL:

IVS-300

Fanless Embedded System with Intel® Skylake ULT / Baytrail Processor, 4 GB DDR3L/DDR4, Quad GbE LAN with PoE, On-board GPS, HDMI, VGA, Dual SSD Bay, RoHS Compliant,

User Manual

Rev. 1.02 – February 1, 2018

RoHS Lead Free

Revision

Date	Version	Changes
February 1, 2018	1.02	Eliminated mSATA support
December 6, 2017	1.01	Added some IVS-300-ULT3 specifications Added the optional OBD-II cable and its connector pinouts Modified Section 3.13: Mobile AP Added Section 3.14: RAID Configuration (ULT3 Model Only)
October 5, 2016	1.00	Initial release

Safety Instructions

en Warning! Read the user manual before connecting the system to the power source.

de Vorsicht! Bitte lesen Sie die Bedienungsanleitung, bevor Sie das System an eine Stromquelle anschließen.

fr Attention! Avant de brancher le système à la source d'alimentation, consultez le mode d'emploi.

it Avvertenza! Consultare il manuale utente prima di collegare il sistema all'alimentatore.

es Atención! Lea atentamente este manual del usuario antes de operar la fuente de alimentación.

zh 警告！在將系統連接到電源之前，請仔細閱讀使用手冊。

cn 警告！在将系统连接到电源之前，请仔细阅读使用手册。

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en Warning! To prevent the system from overheating, do not operate it in an area that exceeds the maximum operating temperature described in the user manual.

de Vorsicht! Um eine Überhitzung des Systems zu vermeiden, betreiben Sie es ausschließlich im zulässigen Betriebstemperaturbereich. Dieser ist in der Bedienungsanleitung vermerkt.

fr Attention! Pour éviter la surchauffe du système, ne l'utilisez pas dans une zone dont la température dépasse les limites décrits dans le mode d'emploi.

it Avvertenza! Per evitare che il sistema si surriscaldi, non utilizzarlo in aree che superino la temperatura massima d'esercizio descritta nel manuale utente.

es Atención! Para evitar el excesivo calentamiento del sistema, no opere en las condiciones de temperatura superior a lo recomendado en este manual del usuario.

zh 警告！為防止系統過熱，不要在使用手冊上記載的產品工作溫度範圍之外操作此系統。

cn 警告！为防止系统过热，不要在使用手册上记载的产品工作温度范围之外操作此系统。

---

en Warning! Use only the adapter and power cord approved for this system. Use of another type of adapter may risk fire or explosion. Please refer to the user manual for the power adapter specifications.

de Vorsicht! Nur zugelassene Netzteile und Netzkabel dürfen verwendet werden. Die Benutzung von anderen Netzteilen kann einen Brand oder eine Explosion zur Folge haben. Prüfen Sie die jeweiligen Spezifikationen in der Bedienungsanleitung.

fr Attention! Utilisez exclusivement le câble d'alimentation et l'adaptateur homologués pour ce système. L'utilisation d'un autre type d'adaptateur risquerait de provoquer un incendie ou une explosion. Veuillez référer au mode d'emploi pour les spécifications de l'adaptateur d'alimentation.

it Avvertenza! Utilizzare solo l'adattatore e il cavo di alimentazione approvati per questo sistema. L'uso di un altro tipo di adattatore può causare rischio d'incendio o esplosione. Si prega di fare riferimento al manuale utente per le specifiche sull'alimentazione.

es Atención! Utilice solamente el adaptador de corriente alterna (CA) con Marcas Conformidad otorgadas. Cualquier otro adaptador no otorgado aumenta el riesgo de explosión o incendio. Por favor consulte el manual del usuario para las especificaciones del adaptador de alimentación.

zh 警告！只能使用經過認證、適用於本系統的電源變壓器與電源線。使用不適用的電源變壓器將可能導致火災或爆炸。電源變壓器規格請參考使用手冊。

cn 警告！只能使用经过认证，适用于本系统的电源适配器与电源线。使用不适用的电源适配器将可能导致火灾或爆炸。电源适配器规格请参考使用手冊。

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en Warning! Ultimate disposal of this product should be handled according to all national laws and regulations.

de Vorsicht! Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

fr Attention! La mise au rebut ou le recyclage de ce produit sont généralement soumis aux lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

it Avvertenza! Lo smaltimento di questo prodotto deve essere eseguito secondo le leggi e i regolamenti locali.

es Atención! La disposición final de residuos de este producto se debe cumplir con las normativas y leyes del país.

zh 警告！本產品的廢棄處理應根據該國家的法律和規章進行。

cn 警告！本产品的废弃处理应根据该国家的法律和规章进行。

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Manual Conventions

WARNING

Warnings appear where overlooked details may cause damage to the equipment or result in personal injury. Warnings should be taken seriously.

CAUTION

Cautionary messages should be heeded to help reduce the chance of losing data or damaging the product.

NOTE

These messages inform the reader of essential but non-critical information. These messages should be read carefully as any directions or instructions contained therein can help avoid making mistakes.

HOT SURFACE

This symbol indicates a hot surface that should not be touched without taking care.

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1

Introduction

1.1 Overview

Figure 1-1: IVS-300 Series Embedded System

The IVS-300 fanless embedded system is powered by Intel® Core™ i5-6300U processor or Intel® Celeron® processor J1900. It is designed for vehicle surveillance applications that require minimum installation space.

The IVS-300 accepts a wide range of DC power input (9 V – 30 V), allowing it to be powered anywhere. Wi-Fi and WWAN capabilities plus four RJ-45 Ethernet connectors with PoE ensure smooth network connectivity. The display interface options include VGA and HDMI with two audio jacks.

Two USB 3.0 ports, two RS-232 ports, one RS-422/485 port and one OBD-II port provide rich I/O options for various applications. The IVS-300 embedded systems are all capable of supporting two 2.5” SATA 6Gb/s solid-state drives.

1.2 Benefits

The IVS-300 embedded system has the following benefits:

- Complete integration saves solution development time and cost
- Secure storage with SATA SSD supported
- Compact size saves space
- Powerful preinstalled 6th generation Intel® processor and motherboard ensures rigorous processing needs can be met

1.3 Features

The IVS-300 has the following features

- RoHS compliant design
- Fanless system
- Intel® Core™ i5-6300U processor or Intel® Celeron® processor J1900 supported
- Quad GbE LAN with PoE IEEE802.3af support
- Support two RS-232 ports and one RS-422/485 port
- Support two USB 3.0 ports
- Support one OBD-II port
- Two SATA 6Gb/s SSD supported
- Two external SIM card slots support WWAN connection
- Optional 802.11b/g/n 1T1R wireless connection

1.4 Model Variations

There are two models in the IVS-300 embedded system series. The model variations are listed in **Table 1-1** below.

	Processor	Memory
IVS-300-ULT3-i5/4G	Intel® Core™ i5-6300U (dual-core, 2.4 GHz, 15W TDP)	4 GB DDR4 preinstalled (max. 32 GB)
IVS-300-BT-J1/4G	Intel® Celeron® J1900 (quad-core, 2.0 GHz, 10W TDP)	4 GB DDR3L preinstalled (max. 8 GB)

Table 1-1: Model Variations

1.5 Front Panel

An overview of the front panel is shown in **Figure 1-2** below.

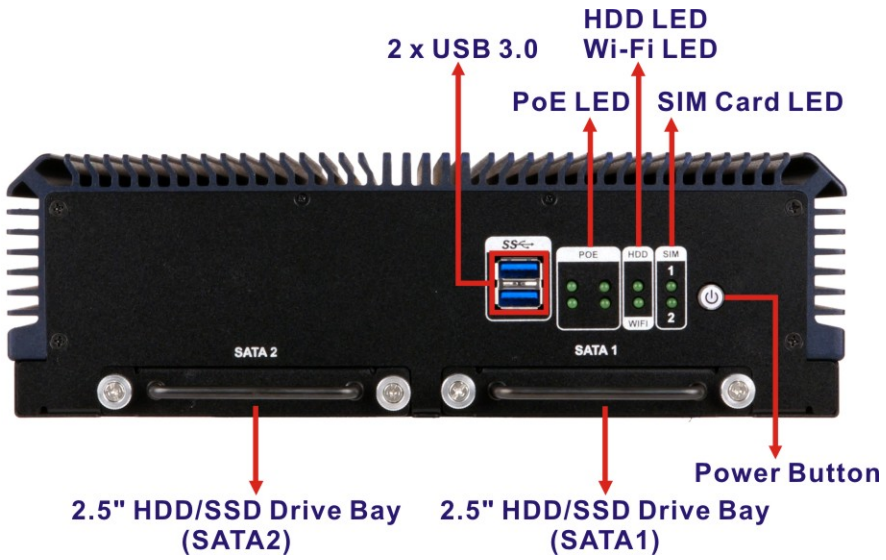


Figure 1-2: Front Panel

1.5.1 LED Indicators

The LED indicators on the front panel show the status of power, HDD, Wi-Fi, PoE and GPRS/HSUPA connection.

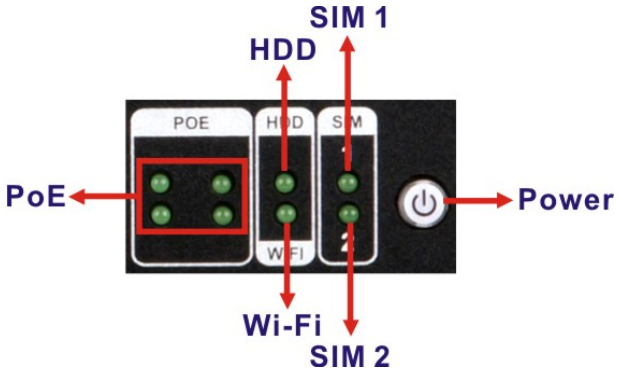


Figure 1-3: LED Indicators

Power LED	Amber	The system is off with power connected
	Blue	The system is turned on

	Blinking	At regular intervals: low voltage warning (configured by BIOS option: Section 4.3.4)
		At irregular intervals (long-short-short): GPS antenna is not connected.
SIM LED	Off	The WWAN module is not installed or the SIM slot is not being used.
	Green	The WWAN module is installed and the SIM slot is being used for WWAN connection.
Wi-Fi LED	Off	The Wi-Fi module is not installed.
	Green	The Wi-Fi module is installed.
HDD LED	Off	HDD is not active
	Blinking	HDD is active
PoE LED	Off	PoE is not connected
	Green	PoE is connected

Table 1-2: LED Indicators

1.6 Rear Panel

An overview of the rear panel is shown in **Figure 1-4**.

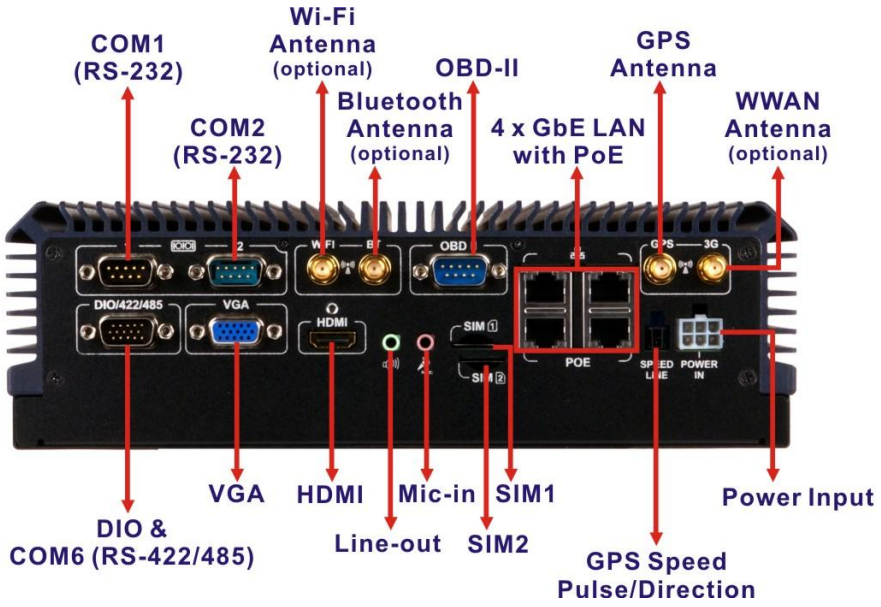


Figure 1-4: Rear Panel

1.7 Bottom Panel

The bottom surface of the IVS-300 contains six retention screw holes for installing two side mounting brackets.

Figure 1-5: Bottom Panel

1.8 Dimensions

The dimensions of the IVS-300 are listed below and shown in **Figure 1-6**.

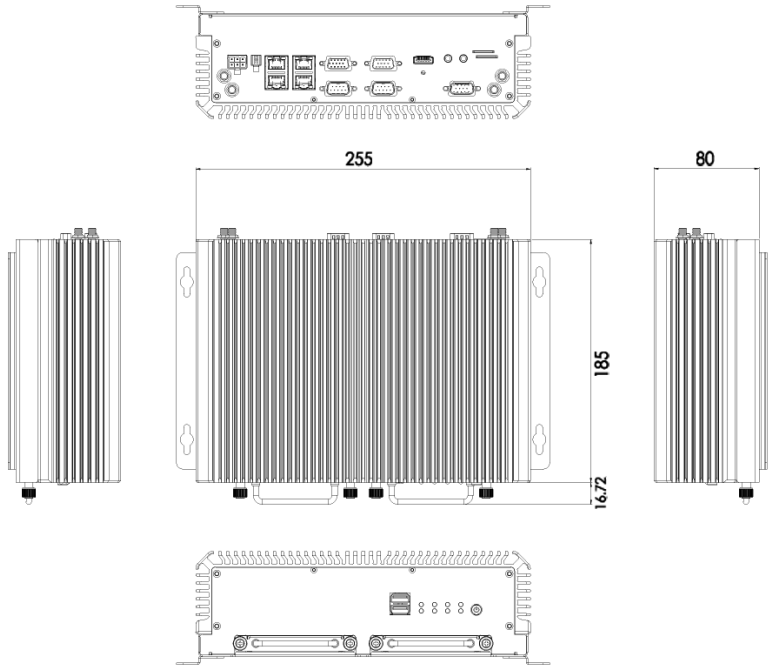


Figure 1-6: Dimensions (mm)

1.9 Technical Specifications

The specifications for the Intel based embedded systems are listed below.

	IVS-300
CPU (SoC)	**ULT3 SKU**: Intel® Core™ i5-6300U (dual-core, 2.4 GHz, 15W TDP) **BT SKU**: Intel® Celeron® J1900 (quad-core, 2.0 GHz, 10W TDP)
System Memory	**ULT3 SKU**: 2 x 260-pin DDR4 SO-DIMM slot (system max. 32 GB) Preinstalled one 4.0 GB DDR4 SDRAM SO-DIMM **BT SKU**: 2 x 204-pin DDR3L SO-DIMM slot (system max. 8 GB) Preinstalled one 4.0 GB DDR3L SDRAM SO-DIMM
Ethernet	4 x PCIe GbE by Intel® I210 Ethernet controller with PoE IEEE802.3af support
GPS	On-board GPS
Wireless LAN	1 x Half-size PCIe Mini card slot reserved for optional 802.11b/g/n 1T1R wireless module (USB + PCIe interface)
WWAN	1 x Full-size PCIe Mini card slot reserved for WWAN module 2 x SIM card slot (on rear panel)
Bluetooth	Bluetooth 2.0 (optional, combo with WWAN)
Display	1 x VGA port 1 x HDMI port
OBD-II/J1939	1 x DB-9 OBD-II/J1939 connector
Serial Port	2 x RS-232 port 1 x Isolated RS-422/485 and digital I/O combo connector
USB	2 x USB 3.0 ports

Audio	1 x Audio line-out 1 x Audio mic-in
Storage	2 x 2.5” SATA 6Gb/s HDD/SSD removable drive bay (ULT3 model supports RAID function)
Chassis Construction	Extruded aluminum alloy
Power Input	9 V – 30 V (±0.3 V) DC One 6-pin power input connector
Power Consumption	12V@13.5A (with Intel® Core™ i5-6300U processor and one 4 GB DDR4 memory)
Operating Shock	Half-sine wave shock 5G; 11ms; 3 shocks per axis
Operating Vibration	MIL-STD-810F 514.5C-2 (with SSD)
Operating Temperature	-20ºC – 60ºC with air flow (with SSD)
Storage Temperature	-30ºC – 70ºC
Humidity	10% – 95%, non-condensing
Color	Black and dark blue
Mounting	Mounting with two mounting brackets
Weight (Net/Gross)	3.0 kg/4.5 kg
Dimensions (W x D x H)	255 mm x 185 mm x 80 mm
EMC	FCC, CE, E-Mark
Supported OS	Microsoft Windows Embedded 8 Microsoft Windows Embedded Standard 7

Table 1-3: Technical Specifications

Chapter

2

Unpacking

2.1 Unpacking

To unpack the embedded system, follow the steps below:

Step 1: Use box cutters, a knife or a sharp pair of scissors that seals the top side of the external (second) box.

Step 2: Open the external (second) box.

Step 3: Use box cutters, a knife or a sharp pair of scissors that seals the top side of the internal (first) box.

Step 4: Lift the system out of the boxes.

Step 5: Remove both polystyrene ends, one from each side.

Step 6: Make sure all the components listed in the packing list are present.

2.2 Packing List

NOTE:

If any of the components listed in the checklist below are missing, do not proceed with the installation. Contact the IEI reseller or vendor the IVS-300 was purchased from or contact an IEI sales representative directly by sending an email to sales@ieiworld.com.

The IVS-300 embedded system is shipped with the following components:

Quantity	Item	Image
1	IVS-300 embedded system	

1	ACC power cable	
1	GPS/GSM antenna	
8	Screws (M3*5) for SSD installation	
6	Screws (M3*6) for mounting brackets	
2	Mounting brackets	
1	Driver and manual CD	

Table 2-1: Package List

2.3 Optional Items

The following are optional component(s) which may be separately purchased:

Power adapter with transfer cable (**P/N**: IVIPOWER-6PIN-R10)	

Wi-Fi kit with AW-CB161H 802.11a/b/g/n/ac and Bluetooth 4.0 combo module (**P/N**: IVS-WIFI-KIT02-R10)	
WWAN kit (**P/N**: IVS-3G-KIT02-R10)	
OBD-II cable (**P/N**: 32025-003400-100-RS)	
OS Image with Windows® Embedded Standard 7 64-bit for IVS-300-BT, DVD-ROM, RoHS (**P/N**: IVS-300-BT-WES7E64-R10)	
OS Image with Windows® Embedded Standard 7 64-bit for IVS-300-ULT3, DVD-ROM, RoHS (**P/N**: IVS-300-ULT3-WES7E64-R10)	

Table 2-2: Optional Items

Chapter

3

Installation

3.1 Anti-static Precautions

WARNING:

Failure to take ESD precautions during the maintenance of the IVS-300 may result in permanent damage to the IVS-300 and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the WAFER series motherboard and the power module. (Dry climates are especially susceptible to ESD.) It is therefore critical that whenever the IVS-300 is opened and any electrical component handled, the following anti-static precautions are strictly adhered to.

- ***Wear an anti-static wristband***: Wearing a simple anti-static wristband can help to prevent ESD from damaging the board.
- ***Self-grounding***: Before handling the board, touch any grounded conducting material. During the time the board is handled, frequently touch any conducting materials that are connected to the ground.
- ***Use an anti-static pad***: When configuring the IVS-300, place it on an anti-static pad. This reduces the possibility of ESD damaging the IVS-300.

3.2 Installation Precautions

During installation, be aware of the precautions below:

- **Read the user manual**: The user manual provides a complete description of the IVS-300, installation instructions and configuration options.
- **DANGER! Disconnect Power**: Power to the IVS-300 must be disconnected during the installation process. Failing to disconnect the power may cause severe injury to the body and/or damage to the system.
- **Qualified Personnel**: The IVS-300 must be installed and operated only by trained and qualified personnel. Maintenance, upgrades, or repairs may only

be carried out by qualified personnel who are familiar with the associated dangers.

- **Air Circulation**: Make sure there is sufficient air circulation when installing the IVS-300. The IVS-300's cooling vents must not be obstructed by any objects. Blocking the vents can cause overheating of the IVS-300. Leave at least 5 cm of clearance around the IVS-300 to prevent overheating.
- **Grounding**: The IVS-300 should be properly grounded. The voltage feeds must not be overloaded. Adjust the cabling and provide external overcharge protection per the electrical values indicated on the label attached to the back of the IVS-300.

3.2.1 High Surface Temperature

WARNING:

Some surfaces of the equipment may become hot during operation.

The surface temperature may be up to several tens of degrees hotter than the ambient temperature. Under these circumstances, the equipment needs to be protected against accidental contact.

The equipment is intended for installation in a RESTRICTED ACCESS LOCATION.

- Access can only be gained by SERVICE PERSONS or by USERS who have been instructed about the reasons for the restrictions applied to the location and about any precautions that shall be taken.
- Access is through the use of a TOOL or lock and key, or other means of security, and is controlled by the authority responsible for the location.

3.3 Installation Procedure

To properly install the IVS-300, the following steps must be followed. Detailed descriptions of these instructions are listed in the sections that follow.

Step 1: Unpacking the IVS-300 embedded system

Step 2: Install WLAN/WWAN module and SIM card (optional)

Step 3: Install SATA SSD

Step 4: Mount the IVS-300

Step 5: Connect the peripheral devices

Step 6: Power the system up

3.4 Disassemble the system

WARNING:

1. Over-tightening bottom cover screws will cause damage to the bottom surface. Maximum torque for cover screws is 5 kg-cm (0.36 lb-ft/0.49 Nm).

2. Never disassemble the system while power is still being fed into the system. Before disassembling the system, make sure the system has been turned off and all power connectors unplugged.

Before the internal component can be installed, the system must be disassembled to access the main board. To disassemble the system, please follow the steps below:

Step 1: Turn the IVS-300 over.

Step 2: Remove the bottom panel retention screws to detach the bottom panel from the chassis (**Figure 3-1**).

Figure 3-1: Bottom Panel Retention Screws

Step 3: Remove the four internal retention screws (**Figure 3-2**).

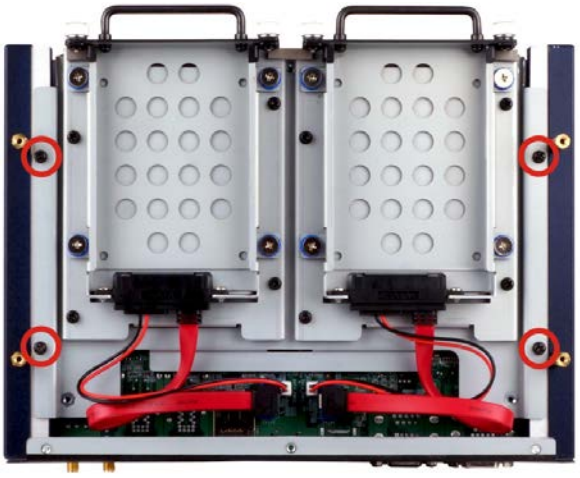


Figure 3-2: Internal Chassis Retention Screws

Step 4: Remove the front panel retention screws to detach the front panel from the chassis (**Figure 3-3**).

Figure 3-3: Front Panel Retention Screws

Step 5: Remove the rear panel retention screws (**Figure 3-4**).

Figure 3-4: Rear Panel Retention Screws

Step 6: Lift the entire internal platform out of the heatsink enclosure carefully (**Figure 3-5**).

Step 7: Turn the internal platform over to access the front side of the main board.

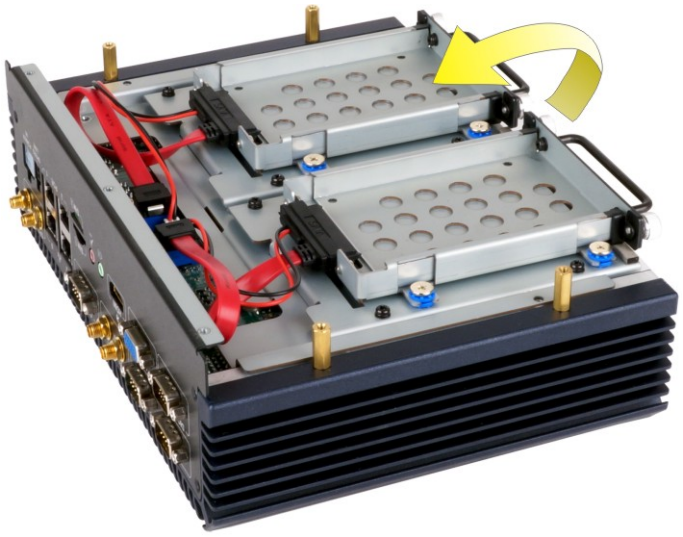


Figure 3-5: Internal Platform Removal

3.5 PCIe Mini Card Installation

The PCIe Mini slot allows installation of either a full-size or half-size PCIe Mini card. To install a full-size PCIe Mini card, please follow the steps below.

Step 1: Access the front side of the main board. See Section 3.4.

Step 2: Locate the PCIe Mini slot (MINI-PCIE3) as shown in **Figure 3-6**.

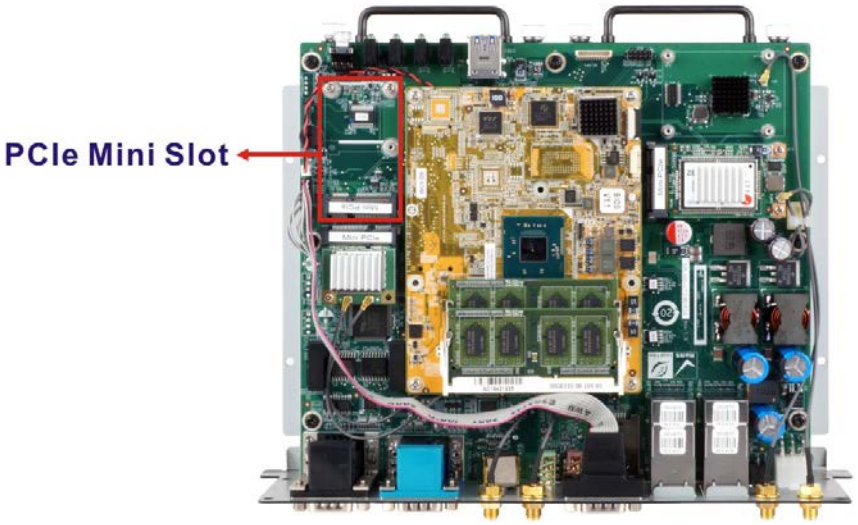


Figure 3-6: PCIe Mini Slot Location

Step 3: Remove the two retention screws as shown in Figure 3-7.

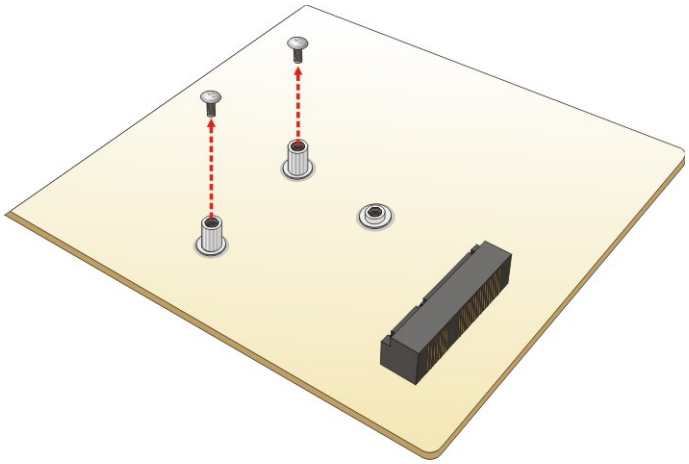


Figure 3-7: Removing the Retention Screws

Step 4: Line up the notch on the card with the notch on the slot. Slide the PCIe Mini card into the socket at an angle of about 20º (**Figure 3-8**).

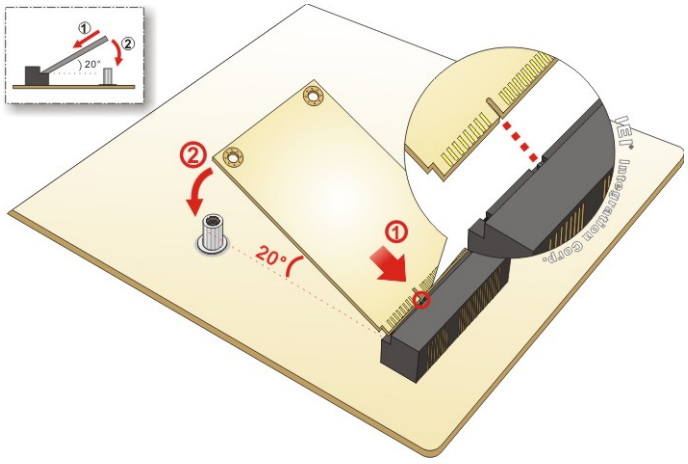


Figure 3-8: Inserting the Full-size PCIe Mini Card into the Slot at an Angle

Step 5: Secure the full-size PCIe Mini card with the retention screws previously removed (**Figure 3-9**).

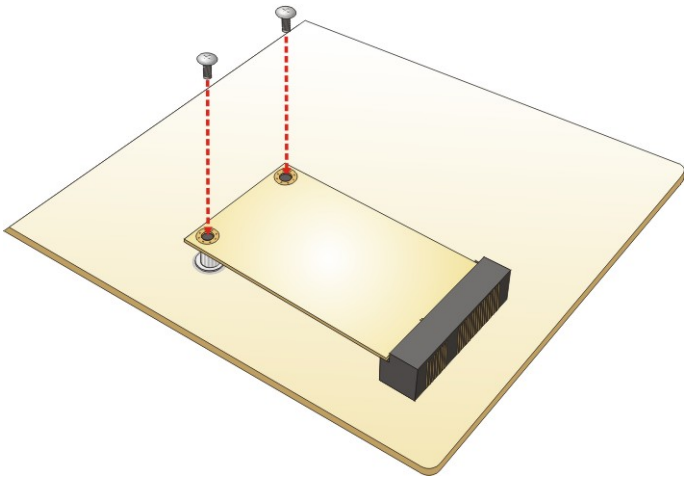


Figure 3-9: Securing the Full-size PCIe Mini Card

3.5.1 PCIe Mini Slot (MINI-PCIE3) Pinouts

The pinouts for the PCIe Mini slot (MINI-PCIE3) are listed in the table below.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	NC	2	VCC3
3	NC	4	GND
5	NC	6	VCC1.5

7	NC	8	SIM_VCC
9	GND	10	SIM_CIO
11	CLK_PCIE_CLK_N	12	SIM_CLK
13	CLK_PCIE_CLK_P	14	SIM_RST
15	GND	16	NC
17	NC	18	GND
19	NC	20	NC
21	GND	22	PCIRST#
23	PCIE_RXN	24	VCC3
25	PCIE_RXP	26	GND
27	GND	28	VCC1.5
29	GND	30	SMB_CLK
31	PCIE_TXN	32	SMB_DATA
33	PCIE_TXP	34	GND
35	GND	36	USB_DATA_N
37	NC	38	USB_DATA_P
39	VCC3	40	GND
41	VCC3	42	NC
43	DUAL3G LED	44	NC
45	NC	46	NC
47	NC	48	VCC1.5
49	NC	50	GND
51	NC	52	VCC3

Table 3-1: PCIe Mini Slot (MINI-PCIE3) Pinouts

3.6 WLAN/WWAN Module Installation

To install the optional WLAN or WWAN module, please follow the steps below.

Step 1: Access the front side of the main board. See Section 3.4.

Step 2: Remove the knockout for antenna installation. The knockouts are located on the rear panel of the IVS-300 as shown in **Figure 3-10**.

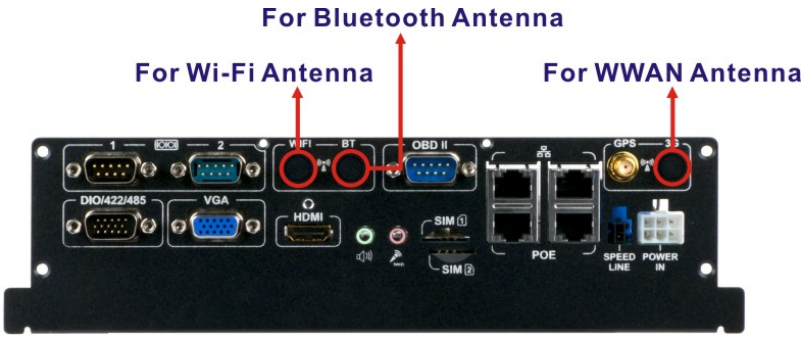


Figure 3-10: Knockouts for External Antennas

Step 3: Locate the half-size PCIe Mini slot for WLAN modules and the full-size PCIe Mini slot for WWAN modules (**Figure 3-11**).

Step 4: Remove the retention screw(s) for PCIe Mini card installation (**Figure 3-11**).

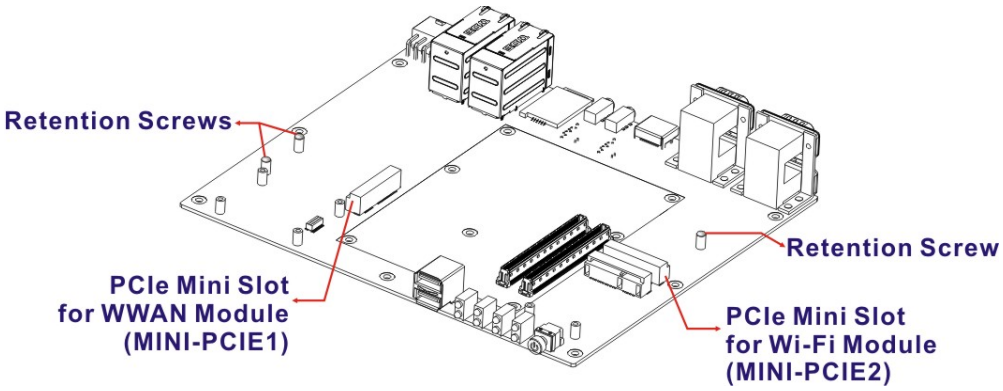


Figure 3-11: WLAN and WWAN Card Slot Locations

Step 5: Line up the notch on the WLAN/WWAN module with the notch on the slot. Slide the WLAN/WWAN module into the slot at an angle of about 20º.

Step 6: Secure the WLAN/WWAN module with the retention screw previously removed.

Step 7: Connect the RF cable(s) to the antenna connector(s) on the WLAN/WWAN module (**Figure 3-12**).

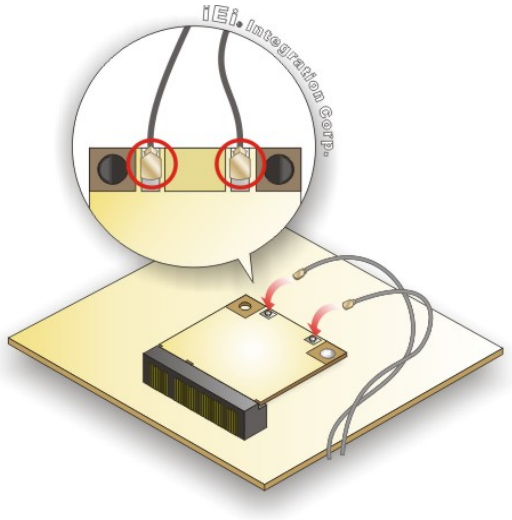


Figure 3-12: Connecting RF Cable

Step 8: Remove the nut and washer from the SMA connector at the other end of the RF cable.

Step 9: Insert the SMA connector to the antenna connector hole on the rear panel.

Step 10: Secure the SMA connector by inserting the washer and tightening it with nut.

Step 11: Install the external antenna.

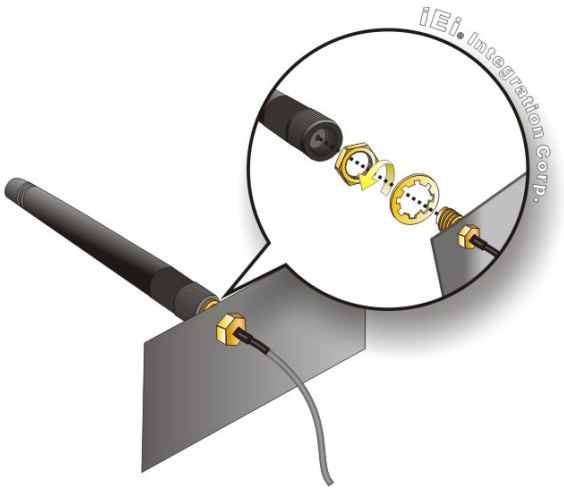


Figure 3-13: Securing SMA Connector and External Antenna Installation

3.6.1 WWAN Module Slot (MINI-PCIE1) Pinouts

The pinouts for the WWAN module slot (MINI-PCIE1) are listed in the table below.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	NC	2	VCC3
3	NC	4	GND
5	NC	6	VCC1.5
7	NC	8	SIM_VCC
9	GND	10	SIM_CIO
11	NC	12	SIM_CLK
13	NC	14	SIM_RST
15	GND	16	NC
17	NC	18	GND
19	NC	20	HSUPA_ON
21	GND	22	NC
23	NC	24	VCC3
25	NC	26	GND
27	GND	28	VCC1.5
29	GND	30	NC
31	NC	32	NC
33	NC	34	GND
35	GND	36	USB_DATA_N
37	NC	38	USB_DATA_P
39	VCC3	40	GND
41	VCC3	42	NC
43	3GLED_EN	44	NC
45	NC	46	NC
47	NC	48	VCC1.5
49	NC	50	GND
51	NC	52	VCC3

Table 3-2: WWAN Module Slot (MINI-PCIE1) Pinouts

3.6.2 WLAN Module Slot (MINI-PCIE2) Pinouts

The pinouts for the WLAN module slot (MINI-PCIE2) are listed in the table below.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	WAKE#	2	VCC3
3	NC	4	GND
5	NC	6	VCC1.5
7	NC	8	NC
9	GND	10	NC
11	CLK_PCIE_CLK_N	12	NC
13	CLK_PCIE_CLK_P	14	NC
15	GND	16	NC
17	NC	18	GND
19	NC	20	NC
21	GND	22	PCIRST#
23	PCIE_RXN	24	VCC3
25	PCIE_RXP	26	GND
27	GND	28	VCC1.5
29	GND	30	SMB_CLK
31	PCIE_TXN	32	SMB_DATA
33	PCIE_TXP	34	GND
35	GND	36	USB_DATA_N
37	NC	38	USB_DATA_P
39	NC	40	GND
41	NC	42	NC
43	NC	44	WIFI_LED
45	NC	46	NC
47	NC	48	VCC1.5
49	NC	50	GND
51	NC	52	VCC3

Table 3-3: WLAN Module Slot (MINI-PCIE2) Pinouts

3.7 SIM Card Installation

To be able to use the WWAN network connection, SIM cards must be installed in the IVS-300. Follow the steps below to install SIM cards.

Step 1: Install a WWAN module into the IVS-300. See Section 3.4.

Step 2: Locate the SIM card slots on the rear panel (Figure 3-14).

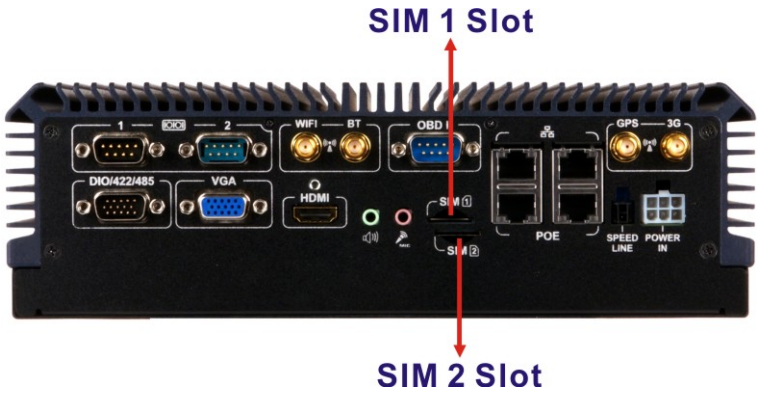


Figure 3-14: SIM Card Slot Locations

Step 3: Insert a SIM card into the SIM 1 slot with the gold contacts facing down. Insert a SIM card into the SIM 2 slot with the gold contacts facing up. To remove the SIM card, push the SIM card to release it.

Step 4: Install IEI Mobile AP to designate a SIM card to use. The Mobile AP instruction is described in detail in **Section 3.13**.

Step 5: The SIM LED indicators on the front panel show the user which SIM card is being used. See **Section 1.5.1**.

3.8 Solid-State Drive Installation

Two 2.5” SATA drives can be installed in the IVS-300. The SATA drives are installed into the removable hard drive brackets on the front panel. To install the SSD into the system, please follow the steps below.

Step 1: Loose the two captive screws that secure one of the brackets on the front panel.

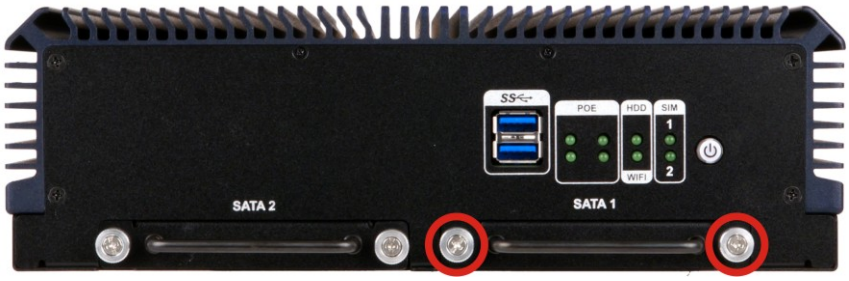


Figure 3-15: SSD Bracket Retention Screws

Step 2: Pull the bracket out to remove the bracket from the IVS-300 (**Figure 3-16**).

Figure 3-16: Removing SSD Bracket

Step 3: Place an SSD onto the bracket and secure the SSD with the bracket by inserting four retention screws (M3*4) into the bottom of the SSD (**Figure 3-17**).

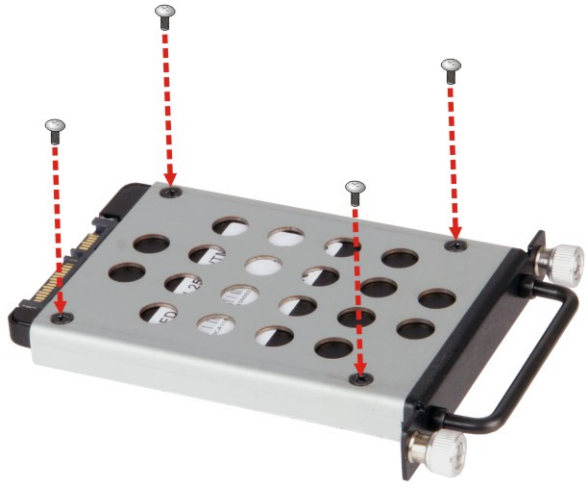


Figure 3-17: SSD Retention Screws

Step 4: Carefully insert the SSD bracket into the slot on the front panel. Make sure the SATA connector on the SSD is securely connected to the SATA connector inside the chassis.

Figure 3-18: SSD Installation

Step 5: Tighten the two captive screws to secure the SSD bracket.

Step 6: Repeat the five steps described above to install the second SSD into the other SSD bracket.

3.9 Mounting the System

To mount the embedded system onto a wall or some other surface using the two mounting brackets, please follow the steps below.

Step 1: Turn the embedded system over.

Step 2: Align the three retention screw holes in each bracket with the retention screw holes on the sides of the bottom surface.

Step 3: Secure the brackets to the system by inserting three retention screws (M3*8) into each bracket (**Figure 3-19**).

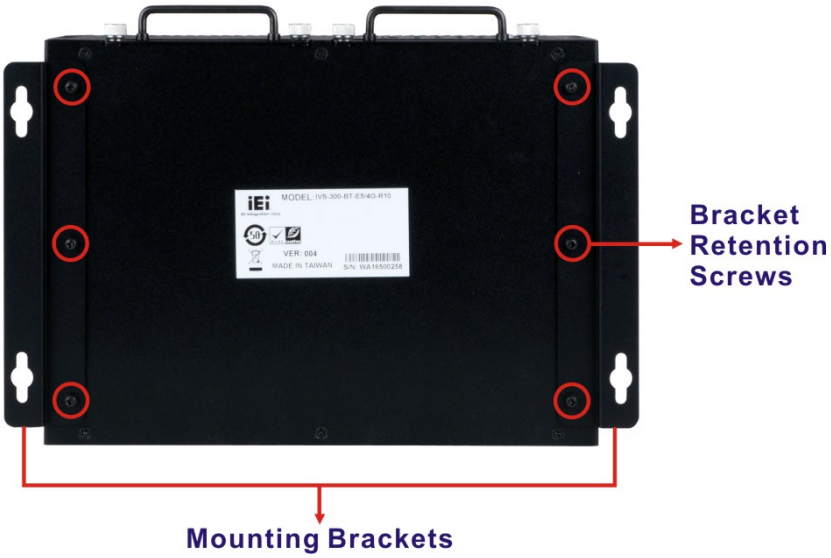


Figure 3-19: Mounting Bracket Retention Screws

Step 4: Drill holes in the intended installation surface.

Step 5: Align the mounting holes in the sides of the mounting brackets with the predrilled holes in the mounting surface.

Step 6: Insert four retention screws, two in each bracket, to secure the system to the wall.

3.10 External I/O Connectors

This section provides an overview of the external I/O connectors of the IVS-300.

3.10.1 COM Port Connection

The IVS-300 has two DB-9 connectors for RS-232 serial port connection. The pinouts for the RS-232 connectors (COM1and COM2) are listed in the figure and table below.

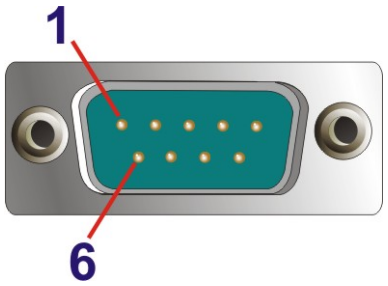


Figure 3-20: RS-232 Connector (COM1, COM2)

PIN NO.	DESCRIPTION
1	DCD
2	RX
3	TX
4	DTR
5	GND
6	DSR
7	RTS
8	CTS
9	RI

Table 3-4: RS-232 Connector Pinouts

3.10.2 DIO and RS-422/485 (COM6) Connection

The IVS-300 has one DB-15 connector for DIO and RS-422/485 (COM6) connection. The pinouts for the DIO and RS-422/485 connector are listed in the figure and table below.

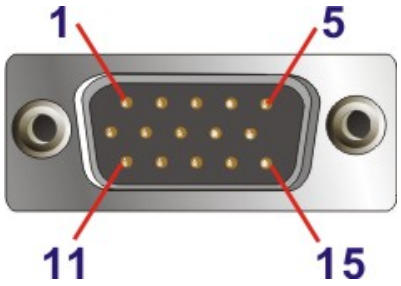


Figure 3-21: DIO and RS-422/485 Connector

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	DIN0	9	DOUT3
2	DIN1	10	GND
3	DIN2	11	TXD422-/TXD485-
4	DIN3	12	TXD422+/TXD485+
5	VCC5	13	RXD422-
6	DOUT0	14	RXD422+
7	DOUT1	15	N/A
8	DOUT2		

Table 3-5: DIO and RS-422/485 Connector Pinouts

3.10.3 OBD-II/J1939 Connection

The IVS-300 has one DB-9 connector for OBD-II/J1939 connection. The pinouts for the OBD-II/J1939 connector are listed in the figure and table below.

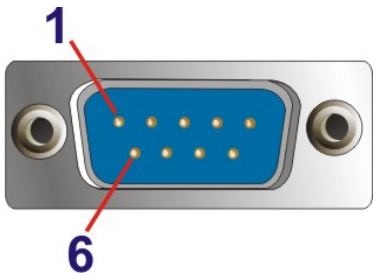


Figure 3-22: OBD-II/J1939 Connector

PIN NO.	DESCRIPTION
1	GND
2	GND
3	OBD-CAN_H
4	ISO-9141-2-K
5	OBD-CAN_L
6	J1850-
7	J1850+
8	ISO-9141-2-L
9	NC

Table 3-6: OBD-II/J1939 Connector Pinouts

NOTE:

Microsoft Windows 10 OS does not support OBD-II and J1939 functions.

User can purchase the optional OBD-II cable (**Figure 3-23**) to connect the IVS-300 with the vehicle.

OBD-II Cable

Figure 3-23: OBD-II Cable

The pinout locations of OBD-II cable connector are shown below.

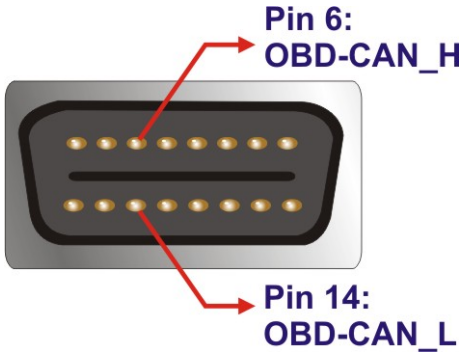


Figure 3-24: OBD-II Connector Pinouts

3.10.4 GPS Speed Pulse/Direction Connection

The IVS-300 has a 2-pin connector for GPS speed pulse/direction connection. The pinouts for the GPS speed pulse/direction connector are listed in the figure and table below.

Figure 3-25: GPS Speed Pulse/Direction Connector

PIN NO.	DESCRIPTION
1	Direction
2	Speed Pulse

Table 3-7: GPS Speed Pulse/Direction Connector Pinouts

3.11 Power-On Procedure

3.11.1 Installation Checklist

WARNING:

Make sure a power supply with the correct input voltage is being fed into the system. Incorrect voltages applied to the system may cause damage to the internal electronic components and may also cause injury to the user.

To power on the embedded system please make sure of the following:

- The bottom cover is installed
- All peripheral devices (monitors, serial communications devices etc.) are connected
- The power cables are plugged in
- The system is securely mounted

3.11.2 Power Input Connection

The IVS-300 has a 9 V – 30 V power input connector. The 6-pin power connector pinouts are listed in the figure and table below.

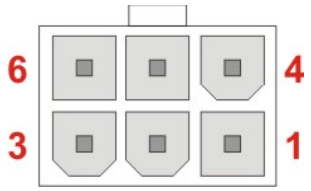


Figure 3-26: Power Input Connector

PIN NO.	DESCRIPTION
1	GND
2	GND
3	GND
4	ACC
5	VIN
6	VIN

Table 3-8: Power Input Connector Pinouts

To use ACC power, connect the IVS-300 to the vehicle through the ACC power cable. See **Figure 3-27**.

Figure 3-27: ACC Power Cable

3.11.3 Power-on Procedure

To power-on the IVS-300 please follow the steps below:

Step 1: Connect the power source to the power connector to provide power to the system.

Step 2: Push the power button until the power LED lights on in green (**Figure 3-28**).

Figure 3-28: Power Button

3.12 Driver Installation

NOTE:

The content of the CD may vary throughout the life cycle of the product and is subject to change without prior notice. Visit the IEI website or contact technical support for the latest updates.

All the drivers for the IVS-300 are on the utility CD that came with the system. The utility CD contains drivers for Windows 7 and Windows 8 operating systems. Please select the corresponding drivers for the system.

The following drivers can be installed on the **Windows 7** operating system:

- Chipset
- Graphics

- Audio
- LAN
- WLAN (including Bluetooth driver, WWAN module driver, WLAN module driver and IEI Mobile AP application tool)
- Others:
  - TXE
  - USB 3.0
  - I/O driver (for ULT3 model only)

The following drivers can be installed on the **Windows 8** operating system:

- Chipset
- Graphics
- Audio
- LAN
- WLAN (including Bluetooth driver, WWAN module driver, WLAN module driver and IEI Mobile AP application tool)
- Others:
  - I/O driver (for ULT3 model only)

Insert the utility CD into a CD drive connected to the system and install all of the necessary drivers for the IVS-300.

3.13 Mobile AP

IEI provides an application tool, Mobile AP, for the users of the IVS-300 with the WWAN module installed to manage mobile network and make a phone call.

3.13.1 Installation

To install this application tool, please locate the **WLAN** folder in the utility CD. This folder contains two files for different operating systems.

- **IEI_Mobile_AP_Setup_x86_vxx.exe** for 32-bit Windows OS
- **IEI_Mobile_AP_Setup_x64_vxx.exe** for 64-bit Windows OS

Double click the .exe file that is corresponding to the OS version, then the system starts to extract the file. After extracting, it starts to install the Bluetooth driver followed by the

installation of the WWAN module driver, and IEI Mobile AP application tool. It is recommended to follow the step-by-step procedure to install all of these three drivers/applications.

NOTE:

After installing the drivers and applications, the IVS-300 must be restarted in order to complete the installation.

3.13.2 Usage

To launch the application, double click the **MobileAP** icon on the Windows desktop. The user interface appears as shown in **Figure 3-29**. The functions are described below.

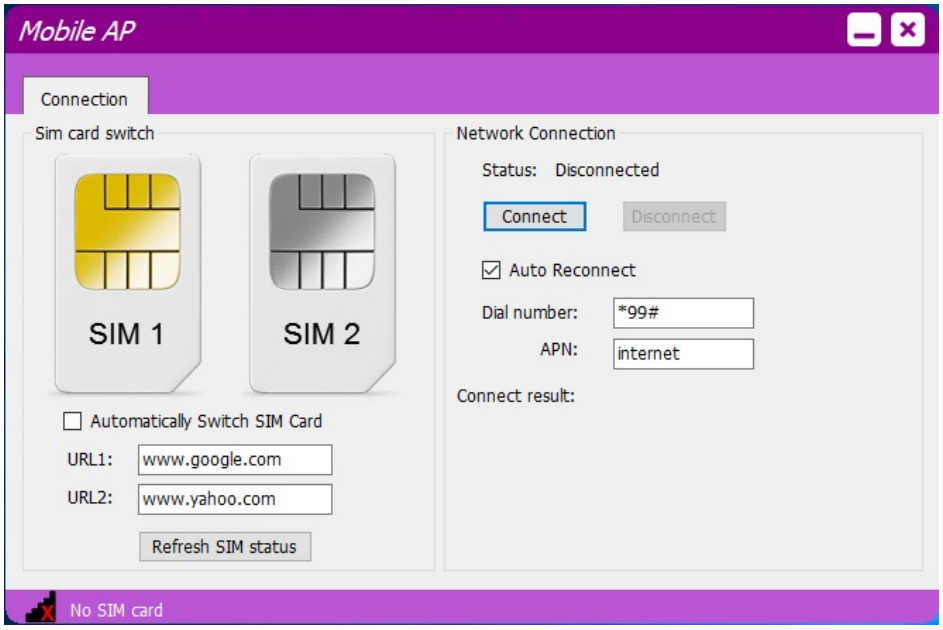


Figure 3-29: Mobile AP – Connection

- **Sim card switch**:
  Select a SIM card to designate a SIM card to use or click the **Refresh SIM status** button to let the system detect automatically.

- **Automatically Switch SIM Card**: check to allow the system to ping URL1 and URL2 every 30 seconds. If the system is unable to ping both URLs in three minutes, the system will automatically switch to the other SIM card.

- **Network Connection**:
  - **Status**: shows the connection status. Click the **Connect** button to connect the selected SIM card to network.
  - **Auto Reconnect**: allows the system to reconnect automatically.
  - **Dial number**: provided by the ISP for mobile network. The default value is ***99#**.
  - **APN** (Access Point Name): provided by the ISP for mobile network. The default value is **internet**.
  - **Connect result**: displays the connection result.

3.14 RAID Configuration (ULT3 Model Only)

The **IVS-300-ULT3-i5** can provide data protection for serial ATA (SATA) disks via the Intel® Rapid Storage Technology. To access the Intel® Rapid Storage Technology, please follow the steps below.

WARNING!

Irrecoverable data loss occurs if a working drive is removed when trying to remove a failed drive. It is strongly recommended to mark the physical connections of all SATA disk drives. Drive locations can be identified by attaching stickers to the drive bays. If a drive member of a RAID array should fail, the failed drive can then be correctly identified.

CAUTION!

Do not accidentally disconnect the SATA drive cables. Carefully route the cables within the chassis to avoid system down time.

Step 1: **Connect SATA drives to the system**. Connect two or more SATA drives to the system. Make sure the drives have the same capacity, are the same type and have the same speed.

NOTE:

Make sure the SATA drives are EXACTLY the same when they are configured in a RAID configuration. If they are not the same size, disk drive capacity is sacrificed and overall performance affected.

Step 2: **Enable SATA drives in BIOS**. Start the computer and access the BIOS setup program. Go to **Advanced** → **SATA Configuration** → **SATA Mode**. Enable RAID support for all SATA devices.

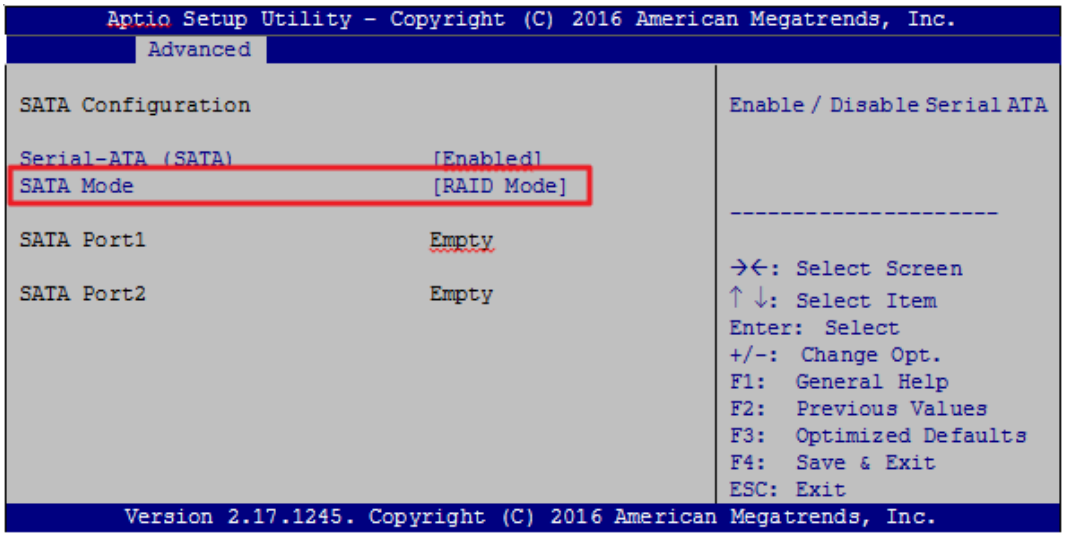


Figure 3-30: RAID Configuration – BIOS Setting

Step 3: **Save and Exit BIOS**. After the SATA support option is enabled, save and exit the BIOS.

Step 4: **Reboot the system**. Reboot the system after saving and exiting the BIOS.

Step 5: **Press Ctrl+I. during the system boot process**, press Ctrl+I when prompted to enter the RAID configuration software.

```
Intel(R) Rapid Storage Technology - Option ROM - 15.2.0.2740
Copyright (C) Intel Corporation. All rights reserved.

  RAID Volumes:
  None defined.

  Physical Devices:
  ID Device Model       Serial #                    Size Type/Status(Vol ID)
  1  256GB SATA Flash   076616F100208548        23.4GB Non-RAID Disk
  2  256GB SATA Flash   077302EF00503528        23.4GB Non-RAID Disk
Press <CTRL+I> to enter Configuration Utility…
```

Step 6: **Configure the RAID settings**. Use the Intel® Rapid Storage Technology to configure the RAID array.

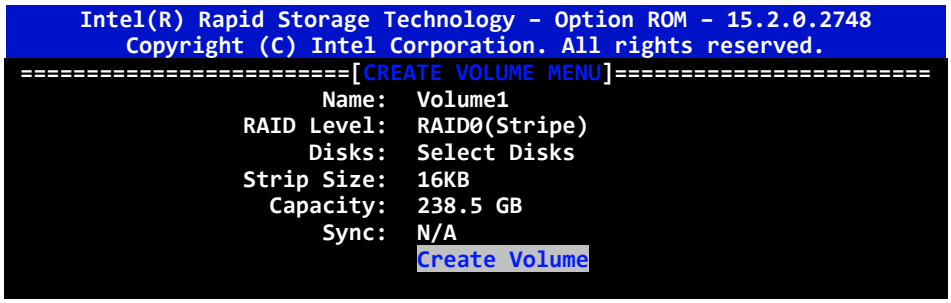
A) Select the option to **Create RAID Volume** from the Main Menu and press Enter.

```
     Intel(R) Rapid Storage Technology - Option ROM - 15.2.0.2748
        Copyright (C) Intel Corporation. All rights reserved.
==============================[MAIN MENU]==============================
         1. Create RAID Volume        4. Recovery Volume Options
         2. Delete RAID Volume        5. Acceleration Options
         3. Reset Disks to Non-RAID   6. Exit
======================[DISK/VOLUME INFORMATION]======================
RAID Volumes:
None defined.
```

B) Press the up/down arrows on the keyboard to choose the **RAID Level** and press Enter. Select the hard drives for the RAID configuration and press Enter when done.

```
     Intel(R) Rapid Storage Technology - Option ROM - 15.2.0.2748
        Copyright (C) Intel Corporation. All rights reserved.
========================[CREATE VOLUME MENU]========================
                     Name:  Volume1
                RAID Level:  RAID0(Stripe)
                    Disks:  Select Disks
               Strip Size:  16KB
                 Capacity:  238.5 GB
                     Sync:  N/A
                            Create Volume
```

Step 7: **Create RAID Volume.** Highlight **Create Volume** and press Enter, then choose Y when the warning prompt appears to create volume.



Chapter

4

BIOS

4.1 Introduction

The BIOS is programmed onto the BIOS chip. The BIOS setup program allows changes to certain system settings. This chapter outlines the options that can be changed.

NOTE:

Some of the BIOS options may vary throughout the life cycle of the product and are subject to change without prior notice.

4.1.1 Starting Setup

The UEFI BIOS is activated when the computer is turned on. The setup program can be activated in one of two ways.

1. Press the **DELETE** key as soon as the system is turned on or
2. Press the **DELETE** key when the "**Press Delete to enter SETUP**" message appears on the screen.

If the message disappears before the **DELETE** key is pressed, restart the computer and try again.

4.1.2 Using Setup

Use the arrow keys to highlight items, press **ENTER** to select, use the PageUp and PageDown keys to change entries, press **F1** for help and press **ESC** to quit. Navigation keys are shown in.

Key	Function
Up arrow	Move to the item above
Down arrow	Move to the item below
Left arrow	Move to the item on the left hand side
Right arrow	Move to the item on the right hand side
+	Increase the numeric value or make changes

Key	Function
-	Decrease the numeric value or make changes
Page up	Move to the next page
Page down	Move to the previous page
Esc	Main Menu – Quit and do not save changes into CMOS Status Page Setup Menu and Option Page Setup Menu -- Exit current page and return to Main Menu
F1 key	General help, only for Status Page Setup Menu and Option Page Setup Menu
F2 key	Load previous values
F3 key	Load optimized defaults
F4 key	Save changes and Exit BIOS

Table 4-1: BIOS Navigation Keys

4.1.3 Getting Help

When **F1** is pressed a small help window describing the appropriate keys to use and the possible selections for the highlighted item appears. To exit the Help Window press **Esc** or the **F1** key again.

4.1.4 BIOS Menu Bar

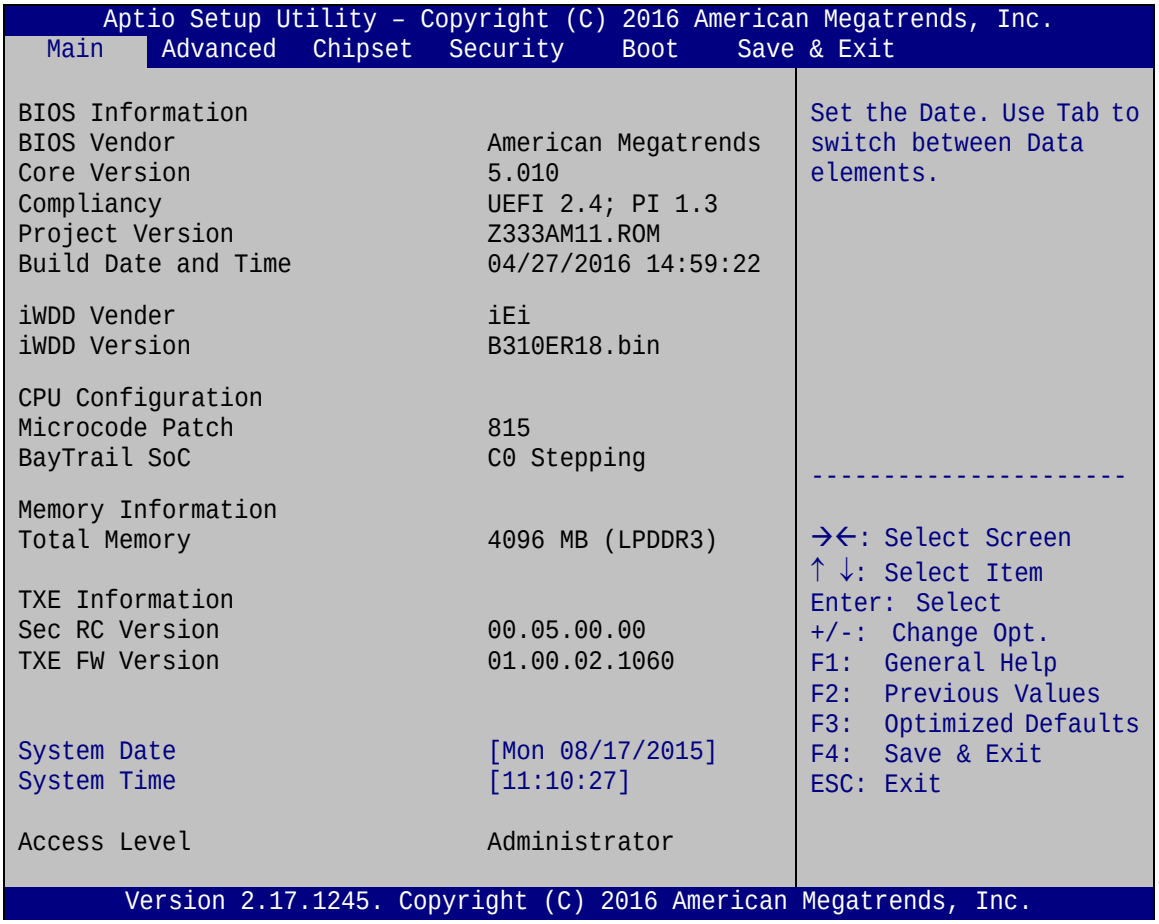
The **menu bar** on top of the BIOS screen has the following main items:

- Main – Changes the basic system configuration.
- Advanced – Changes the advanced system settings.
- Chipset – Changes the chipset settings.
- Security – Sets User and Supervisor Passwords.
- Boot – Changes the system boot configuration.
- Save & Exit – Selects exit options and loads default settings

The following sections completely describe the configuration options found in the menu items at the top of the BIOS screen and listed above.

4.2 Main

The **Main** BIOS menu (**BIOS Menu 1**) appears when the **BIOS Setup** program is entered. The **Main** menu gives an overview of the basic system information.



BIOS Menu 1: Main

The **Main** menu has two user configurable fields:

➔ **System Date [xx/xx/xx]**

Use the **System Date** option to set the system date. Manually enter the day, month and year.

➔ **System Time [xx:xx:xx]**

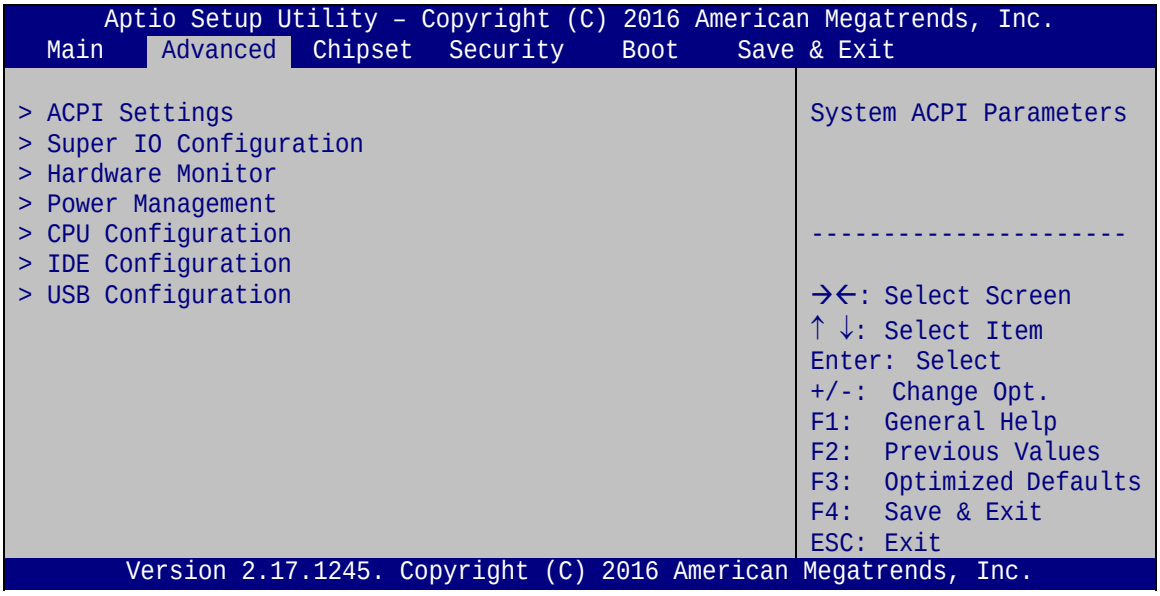
Use the **System Time** option to set the system time. Manually enter the hours, minutes and seconds.

4.3 Advanced

Use the **Advanced** menu (**BIOS Menu 2**) to configure the CPU and peripheral devices through the following sub-menus:

WARNING!

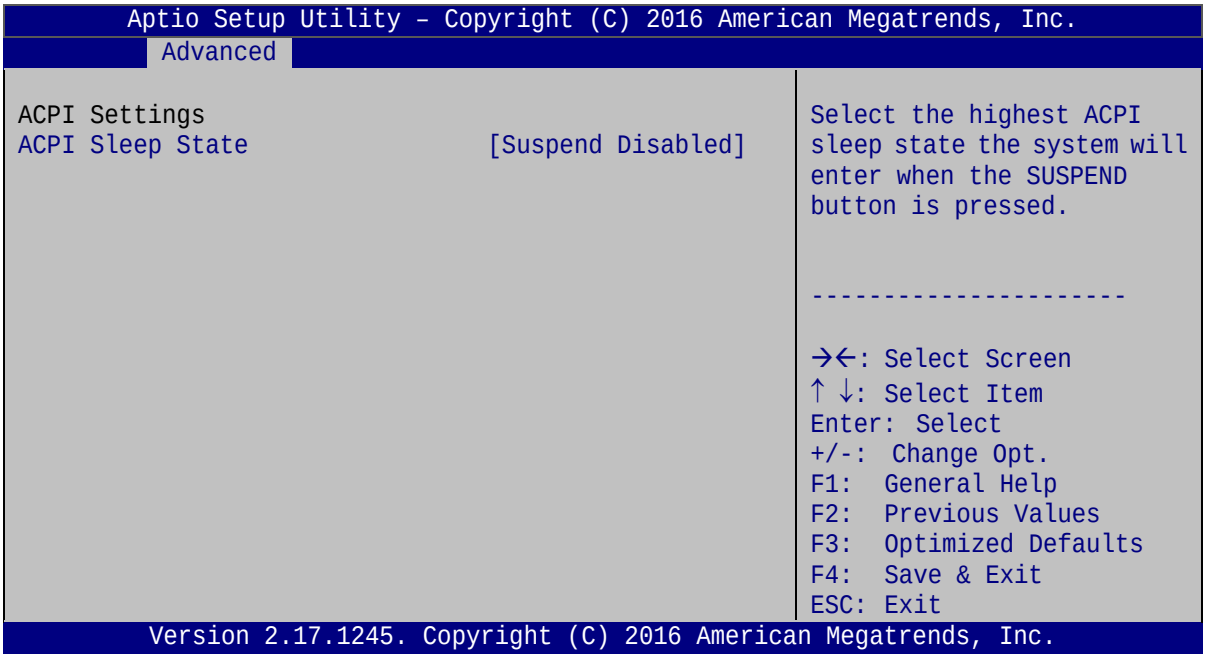
Setting the wrong values in the sections below may cause the system to malfunction. Make sure that the settings made are compatible with the hardware.



BIOS Menu 2: Advanced

4.3.1 ACPI Settings

The **ACPI Settings** menu (**BIOS Menu 3**) configures the Advanced Configuration and Power Interface (ACPI) options.



BIOS Menu 3: ACPI Settings

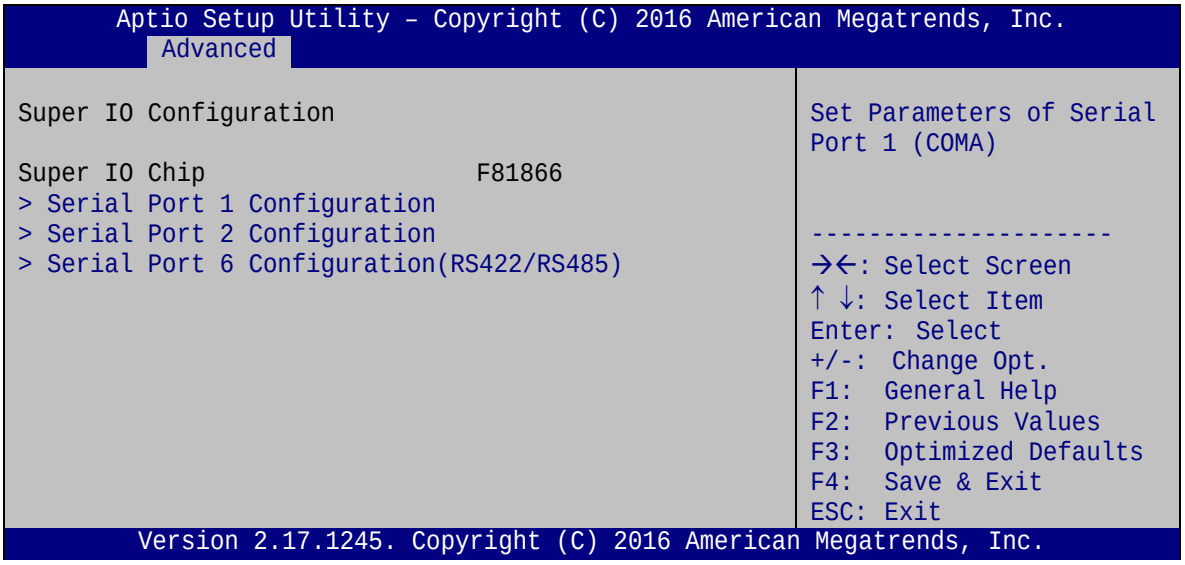
➔ **ACPI Sleep State [Suspend Disabled]**

Use the **ACPI Sleep State** option to specify the sleep state the system enters when it is not being used.

➔ **Suspend Disabled** **DEFAULT** The sleep state is disabled.

4.3.2 Super IO Configuration

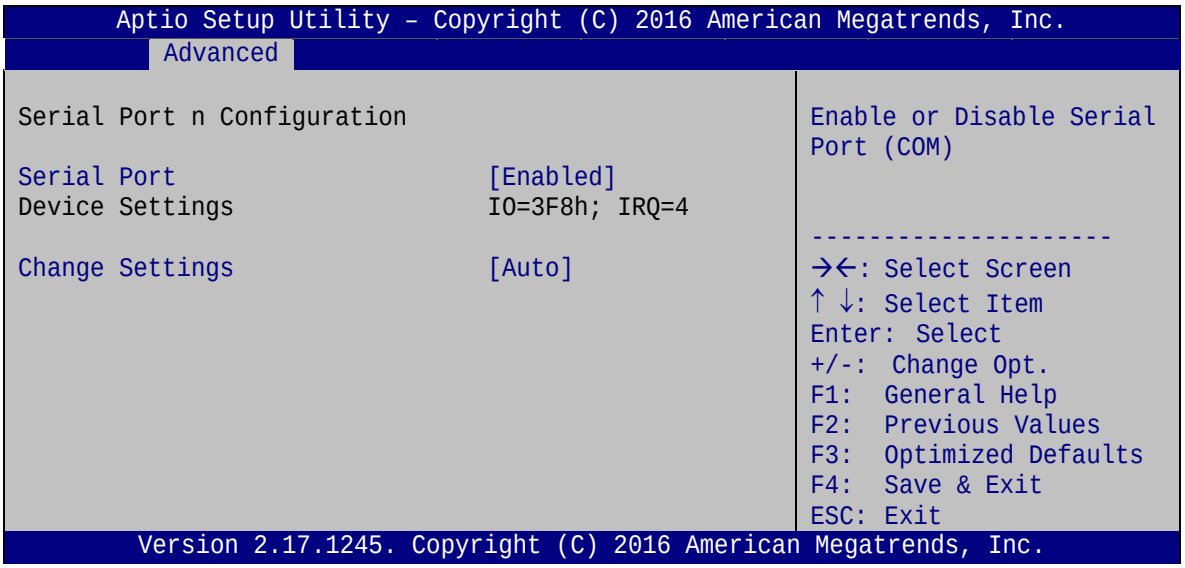
Use the **Super IO Configuration** menu (**BIOS Menu 4**) to set or change the configurations for the serial ports.



BIOS Menu 4: Super IO Configuration

4.3.2.1 Serial Port n Configuration

Use the **Serial Port n Configuration** menu (**BIOS Menu 5**) to configure the serial port n.



BIOS Menu 5: Serial Port n Configuration Menu

4.3.2.1.1 Serial Port 1 Configuration

➔ **Serial Port [Enabled]**

Use the **Serial Port** option to enable or disable the serial port.

➔ **Disabled**		Disable the serial port
➔ **Enabled**	**DEFAULT**	Enable the serial port

➔ **Change Settings [Auto]**

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

➔ **Auto**	**DEFAULT**	The serial port IO port address and interrupt address are automatically detected.
➔ **IO=3F8h; IRQ=4**		Serial Port I/O port address is 3F8h and the interrupt address is IRQ4
➔ **IO=3F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**		Serial Port I/O port address is 3F8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
➔ **IO=2F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**		Serial Port I/O port address is 2F8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
➔ **IO=3E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**		Serial Port I/O port address is 3E8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12

- ➔ **IO=2E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12** — Serial Port I/O port address is 2E8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12

4.3.2.1.2 Serial Port 2 Configuration

➔ **Serial Port [Enabled]**

Use the **Serial Port** option to enable or disable the serial port.

- ➔ **Disabled** — Disable the serial port
- ➔ **Enabled** **DEFAULT** — Enable the serial port

➔ **Change Settings [Auto]**

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

- ➔ **Auto** **DEFAULT** — The serial port IO port address and interrupt address are automatically detected.
- ➔ **IO=2F8h; IRQ=3** — Serial Port I/O port address is 2F8h and the interrupt address is IRQ3
- ➔ **IO=3F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12** — Serial Port I/O port address is 3F8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
- ➔ **IO=2F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12** — Serial Port I/O port address is 2F8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12

➔ **IO=3E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**		Serial Port I/O port address is 3E8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
➔ **IO=2E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**		Serial Port I/O port address is 2E8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12

4.3.2.1.3 Serial Port 6 Configuration (RS422/RS485)

➔ **Serial Port [Enabled]**

Use the **Serial Port** option to enable or disable the serial port.

➔ **Disabled**		Disable the serial port
➔ **Enabled**	**DEFAULT**	Enable the serial port

➔ **Change Settings [Auto]**

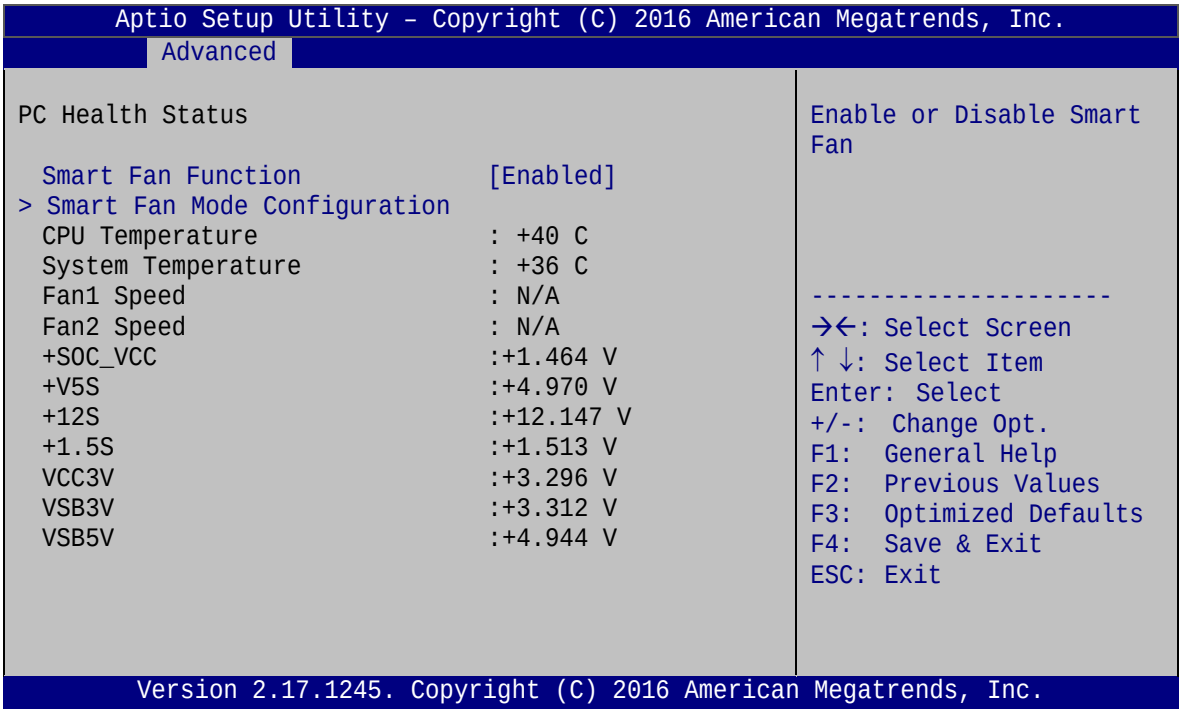
Use the **Change Settings** option to change the serial port IO port address and interrupt address.

➔ **Auto**	**DEFAULT**	The serial port IO port address and interrupt address are automatically detected.
➔ **IO=2E0h; IRQ=11**		Serial Port I/O port address is 2E0h and the interrupt address is IRQ11
➔ **IO=3F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**		Serial Port I/O port address is 3F8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12

➔ **IO=2F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**	Serial Port I/O port address is 2F8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
➔ **IO=3E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**	Serial Port I/O port address is 3E8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
➔ **IO=2E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**	Serial Port I/O port address is 2E8h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
➔ **IO=3E0h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**	Serial Port I/O port address is 3E0h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12
➔ **IO=2E0h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12**	Serial Port I/O port address is 2E0h and the interrupt address is IRQ3, 4, 5, 6, 7, 9, 10, 11, 12

4.3.3 Hardware Monitor

The **Hardware Monitor** menu (**BIOS Menu 6**) displays operating temperature and fan speeds.



BIOS Menu 6: Hardware Monitor

➔ **Smart Fan Function [Enabled]**

Use the **Smart Fan Function** option to enable or disable the smart fan function.

➔ **Disabled** Disables the smart fan function.

➔ **Enabled** **DEFAULT** Enables the smart fan function.

➔ **PC Health Status**

The following system parameters and values are shown. The system parameters that are monitored are:

- Temperature:
  - CPU Temperature
  - System Temperature

- Fan Speed:
  - Fan1 speed
  - Fan2 speed
- Voltages:
  - +SOC_VCC
  - +V5S
  - +12S
  - +1.5S
  - VCC3V
  - VSB3V
  - VSB5V

4.3.3.1 Smart Fan Mode Configuration

Use the **Smart Fan Mode Configuration** submenu (**BIOS Menu 7**) to configure fan temperature and speed settings.

```
Aptio Setup Utility – Copyright (C) 2016 American Megatrends, Inc.
        Advanced
Smart Fan Mode Configuration                    Smart Fan Mode Select

CPU_FAN1 Smart Fan Control      [Auto Duty-Cycle Mode]
CPU Temperature 1               60
CPU Temperature 2               50
CPU Temperature 3               40
CPU Temperature 4               30
SYS_FAN1 Smart Fan Control      [Auto Duty-Cycle Mode]
System Temperature 1            60
System Temperature 1            50
System Temperature 1            40
System Temperature 1            30
                                ----------------------
                                ←→: Select Screen
                                ↑ ↓: Select Item
                                EnterSelect
                                + -   Change Opt.
                                F1    General Help
                                F2    Previous Values
                                F3    Optimized Defaults
                                F4    Save & Exit
                                ESC   Exit
Version 2.17.1245. Copyright (C) 2016 American Megatrends, Inc.
```

BIOS Menu 7: Smart Fan Mode Configuration

➔ **CPU_FAN1 Smart Fan Control [Auto Duty-Cycle Mode]**

Use the **CPU_FAN1 Smart Fan Control** BIOS option to configure the CPU Smart Fan.

➔ **Manual Duty Mode**	The fan spins at the speed set in the Manual Duty Mode option
➔ **Auto Duty-Cycle Mode** **DEFAULT**	The fan adjusts its speed using these settings: CPU Temperature 1 CPU Temperature 2 CPU Temperature 3 CPU Temperature 4

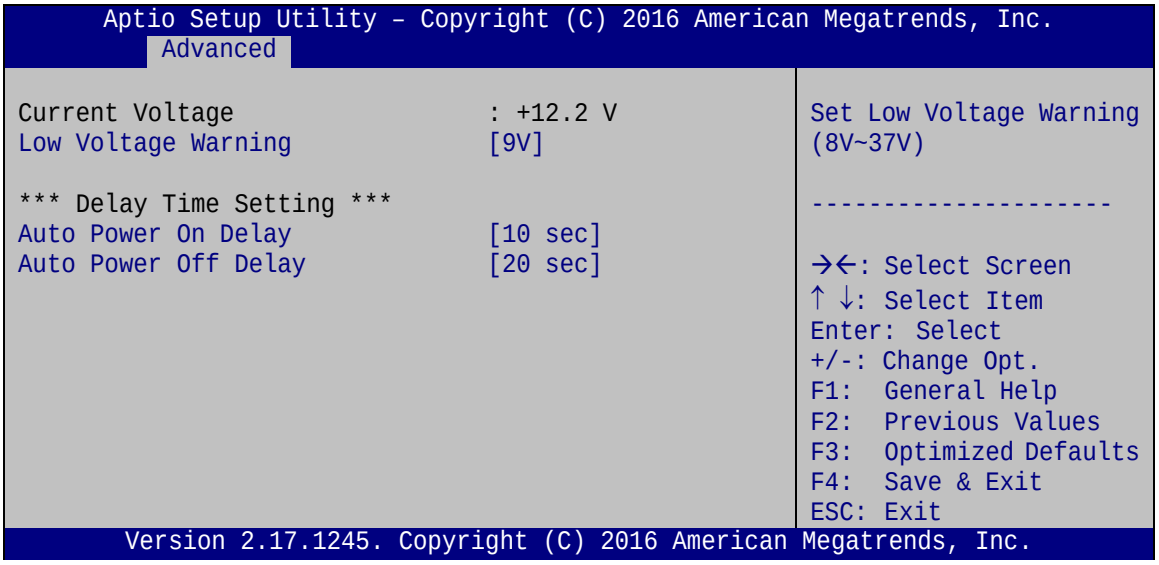
➔ **SYS_FAN1 Smart Fan Control [[Auto Duty-Cycle Mode]**

Use the **SYS_FAN1 Smart Fan Control** BIOS option to configure the system smart fan.

➔ **Manual Duty Mode**	The fan spins at the speed set in the Manual Duty Mode option
➔ **Auto Duty-Cycle Mode** **DEFAULT**	The fan adjusts its speed using these settings: System Temperature 1 System Temperature 2 System Temperature 3 System Temperature 4

4.3.4 Power Management

Use the **Power Management** menu (**BIOS Menu 8**) to configure the power management function.



BIOS Menu 8: Power Management

➔ **Low Voltage Warning [9V]**

Use the **Low Voltage Warning** option to set the low voltage warning from 8V to 37V. If the system voltage is lower than the value set here, the power LED on the system front panel will blink at regular intervals (refer to **Section 1.5.1**) to warn users.

➔ **Auto Power On Delay [10 sec]**

Use the **Auto Power On Delay** option to set the automatic power-on delay time. Configuration options are listed below.

- 10 sec **DEFAULT**
- 30 sec
- 1 min
- 5 min
- 10 min
- 15 min
- 30 min

- 1 hour

➔ **Auto Power Off Delay [20 sec]**

Use the **Auto Power Off Delay** option to set the automatic power-off delay time. Configuration options are listed below.

- 20 sec **DEFAULT**
- 1 min
- 5 min
- 10 min
- 30 min
- 1 hour
- 6 hour
- 18 hour

4.3.4.1 Power State

The following table shows the relation of the power state and vehicle ignition system. The auto start-up and shut down time delay can be set by the BIOS options listed above.

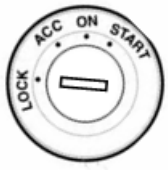
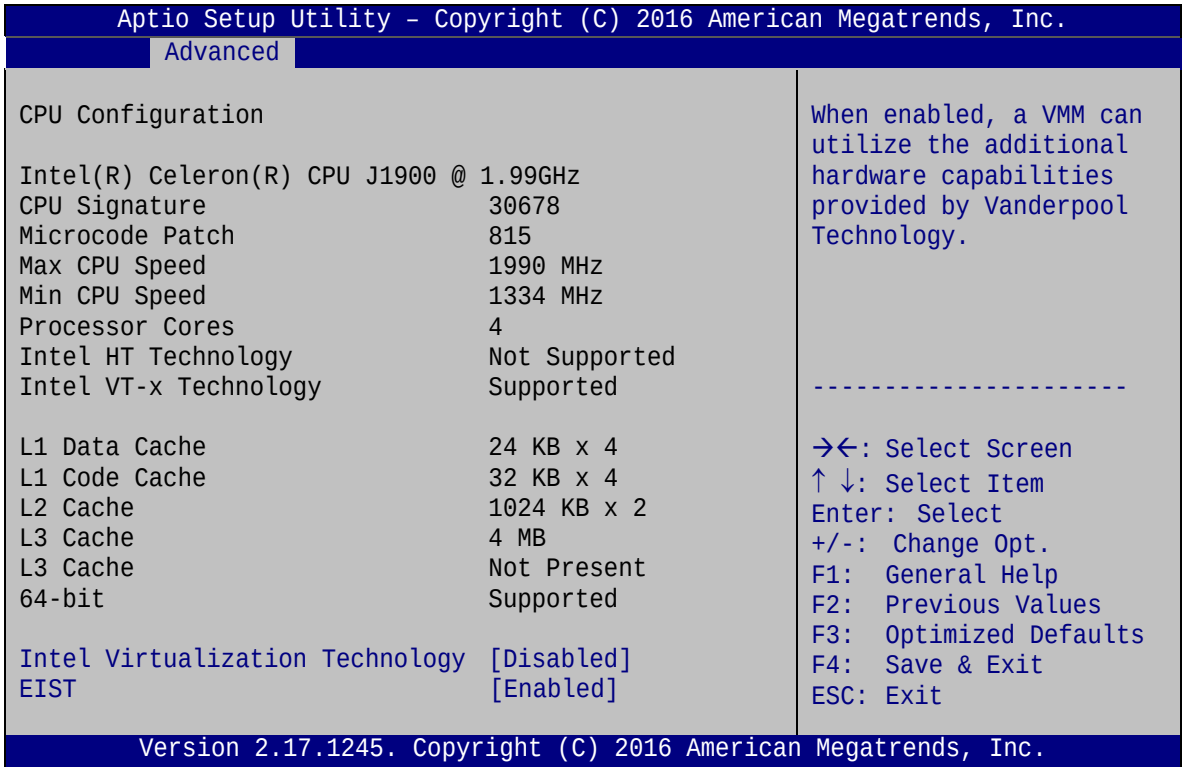
	LOCK 	**ACC** 	**ON** 	**START** 
ACC Signal	Off	On	On	Off
Car Cigarette Lighter	Off	On	On	Off
5 V Standby Power	Off	On after 1 second	On	On
Auto Start-up	--	Set by **Auto Power On Delay** BIOS option		--
Auto Shut-down	Set by **Auto Power Off Delay** BIOS option	--	--	--

Table 4-2: Power State and Ignition System

4.3.5 CPU Configuration

Use the **CPU Configuration** menu (**BIOS Menu 9**) to view detailed CPU specifications and configure the CPU.



BIOS Menu 9: CPU Configuration

The CPU Configuration menu (**BIOS Menu 9**) lists the following CPU details:

- CPU Signature: Lists the CPU signature value.
- Microcode Patch: Lists the microcode patch being used.
- Max CPU Speed: Lists the maximum CPU processing speed.
- Min CPU Speed: Lists the minimum CPU processing speed.
- Processor Cores: Lists the number of the processor core
- Intel HT Technology: Indicates if Intel HT Technology is supported by the CPU.
- Intel VT-x Technology: Indicates if Intel VT-x Technology is supported by the CPU.
- L1 Data Cache: Lists the amount of data storage space on the L1 cache.
- L1 Code Cache: Lists the amount of code storage space on the L1 cache.
- L2 Cache: Lists the amount of storage space on the L2 cache.

- L3 Cache: Lists the amount of storage space on the L3 cache.
- L4 Cache: Lists the amount of storage space on the L4 cache.
- 64-bit: Indicates if 64-bit system is supported by the CPU.

➔ **Intel Virtualization Technology [Disabled]**

Use the **Intel Virtualization Technology** option to enable or disable virtualization on the system. When combined with third party software, Intel® Virtualization technology allows several OSs to run on the same system at the same time.

➔	**Disabled**	**DEFAULT**	Disables Intel Virtualization Technology.
➔	**Enabled**		Enables Intel Virtualization Technology.

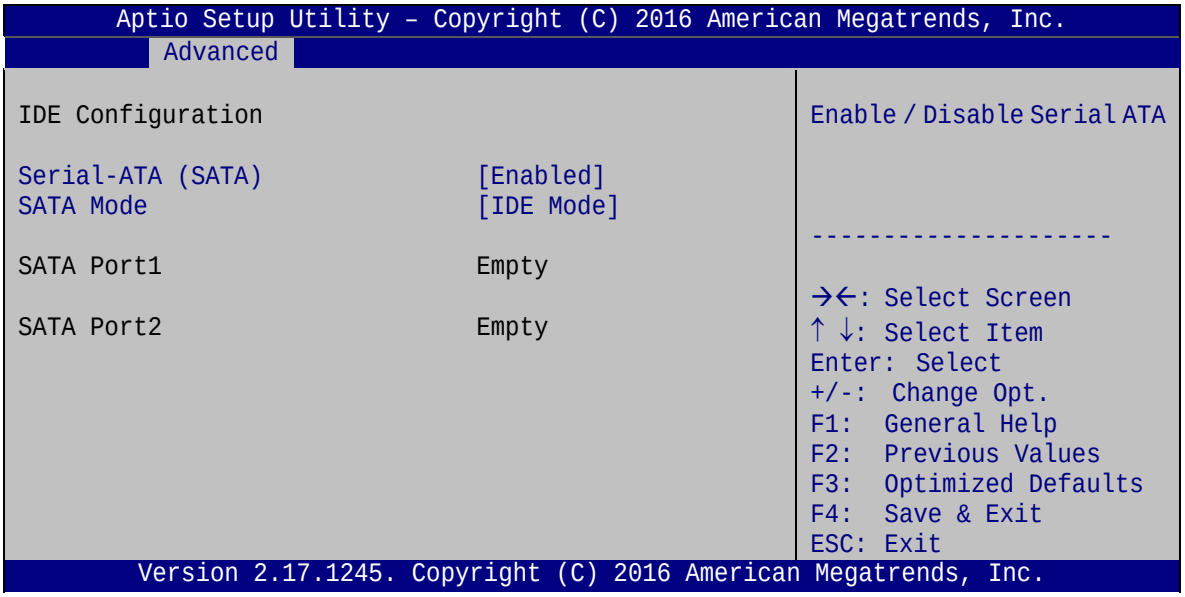
➔ **EIST [Enabled]**

Use the **EIST** option to enable or disable the Enhanced Intel® SpeedStep Technology (EIST).

➔	**Disabled**		Disables Enhanced Intel® SpeedStep Technology
➔	**Enabled**	**DEFAULT**	Enables Enhanced Intel® SpeedStep Technology

4.3.6 IDE Configuration

Use the **IDE Configuration** menu (**BIOS Menu 10**) to change and/or set the configuration of the SATA devices installed in the system.



BIOS Menu 10: IDE Configuration

➔ **Serial-ATA (SATA) [Enabled]**

Use the **Serial-ATA (SATA)** option to configure the SATA controller.

➔ **Enabled** **DEFAULT** Enables the on-board SATA controller.

➔ **Disabled** Disables the on-board SATA controller.

➔ **SATA Mode [IDE Mode]**

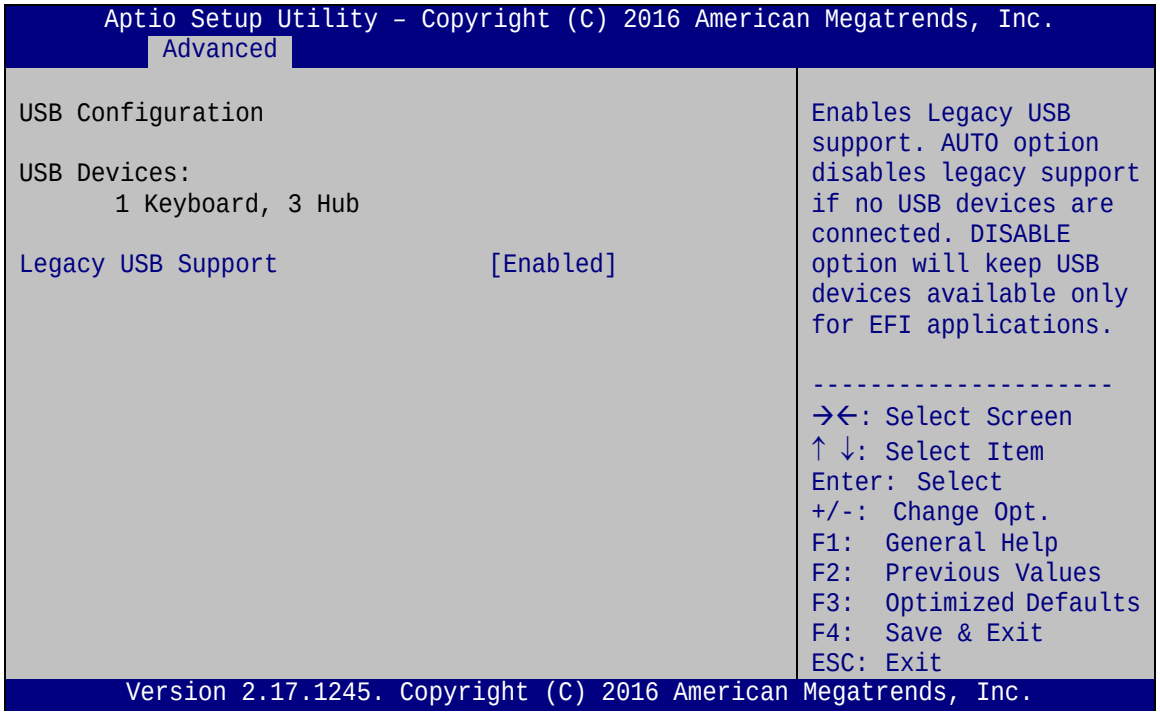
Use the **SATA Mode** option to configure SATA devices as normal IDE or AHCI devices.

➔ **IDE Mode** **DEFAULT** Configures SATA devices as normal IDE device.

➔ **AHCI Mode** Configures SATA devices as AHCI device.

4.3.7 USB Configuration

Use the **USB Configuration** menu (**BIOS Menu 11**) to read USB configuration information and configure the USB settings.



BIOS Menu 11: USB Configuration

➔ **USB Devices**

The **USB Devices** field lists the USB devices that are enabled on the system

➔ **Legacy USB Support [Enabled]**

Use the **Legacy USB Support** BIOS option to enable USB mouse and USB keyboard support. Normally if this option is not enabled, any attached USB mouse or USB keyboard does not become available until a USB compatible operating system is fully booted with all USB drivers loaded. When this option is enabled, any attached USB mouse or USB keyboard can control the system even when there is no USB driver loaded onto the system.

➔	**Enabled**	**DEFAULT**	Legacy USB support enabled
➔	**Disabled**		Legacy USB support disabled
➔	**Auto**		Legacy USB support disabled if no USB devices are connected

4.4 Chipset

Use the **Chipset** menu (**BIOS Menu 12**) to access the North Bridge and South Bridge configuration menus.

WARNING!

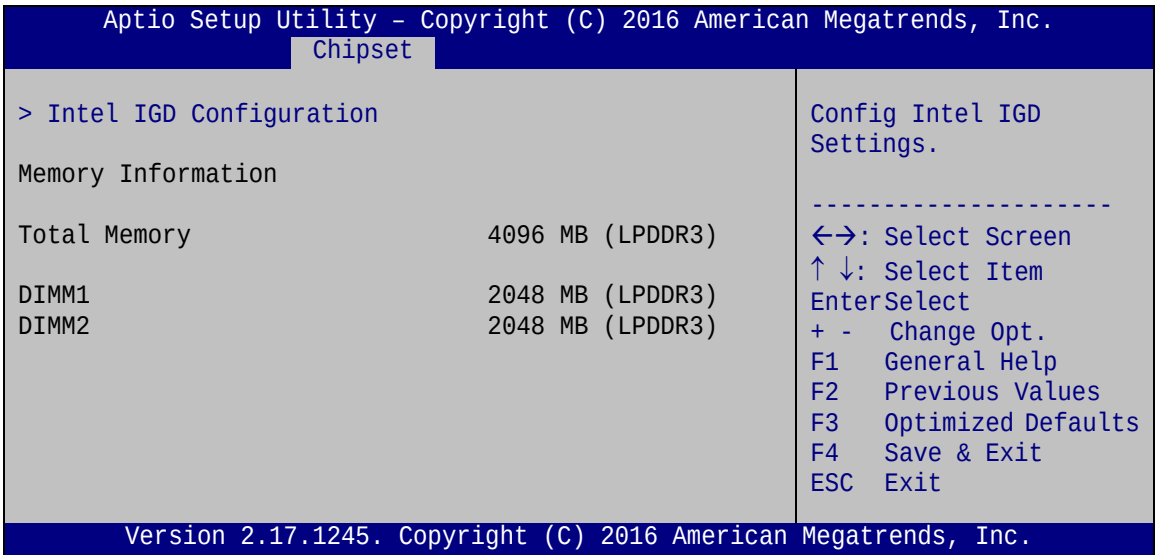
Setting the wrong values for the Chipset BIOS selections in the Chipset BIOS menu may cause the system to malfunction.

```
      Aptio Setup Utility – Copyright (C) 2016 American Megatrends, Inc.
  Main    Advanced  Chipset  Security    Boot    Save & Exit

> North Bridge                                  Host Bridge Parameters
> South Bridge


                                                ----------------------
                                                →←: Select Screen
                                                ↑ ↓: Select Item
                                                Enter:  Select
                                                +/-:  Change Opt.
                                                F1:   General Help
                                                F2:   Previous Values
                                                F3:   Optimized Defaults
                                                F4:   Save & Exit
                                                ESC:  Exit
      Version 2.17.1245. Copyright (C) 2016 American Megatrends, Inc.
```

BIOS Menu 12: Chipset

4.4.1 North Bridge Configuration

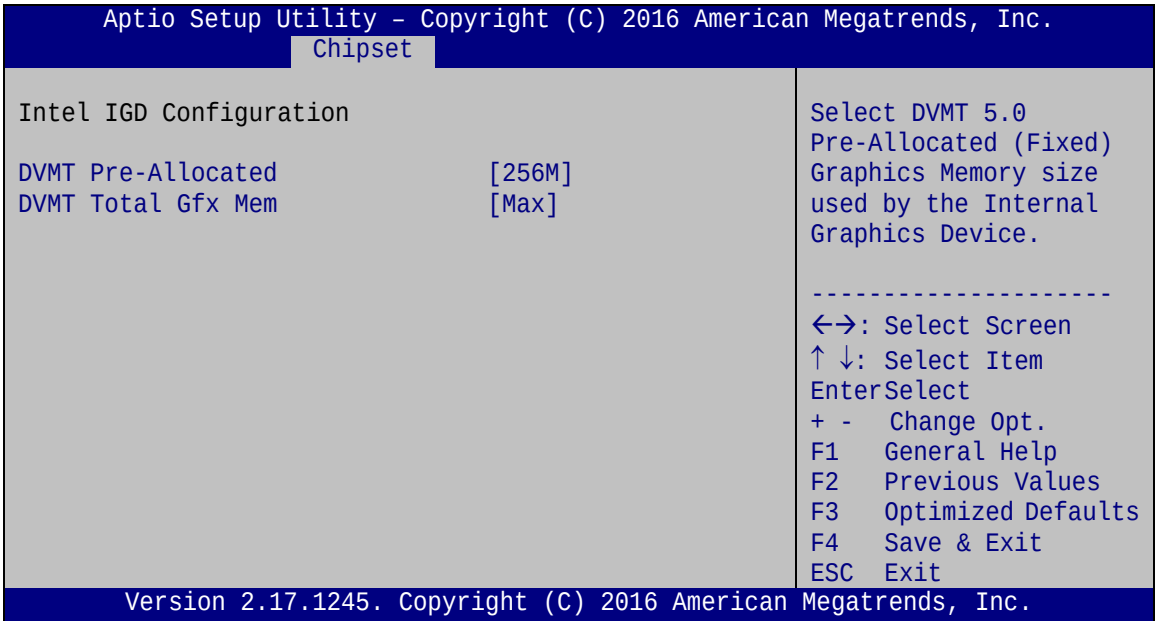
Use the **North Bridge** menu (**BIOS Menu 13**) to configure the north bridge chipset.



BIOS Menu 13: North Bridge

4.4.1.1 Intel IGD Configuration

Use the **Intel IGD Configuration** submenu (**BIOS Menu 14**) to configure the graphics settings.



BIOS Menu 14: Intel IGD Configuration

➔ **DVMT Pre-Allocated [256M]**

Use the **DVMT Pre-Allocated** option to specify the amount of system memory that can be used by the internal graphics device.

➔ **64M**		64 MB of memory used by internal graphics device
➔ **128M**		128 MB of memory used by internal graphics device
➔ **256M**	**DEFAULT**	256 MB of memory used by internal graphics device
➔ **512M**		512 MB of memory used by internal graphics device

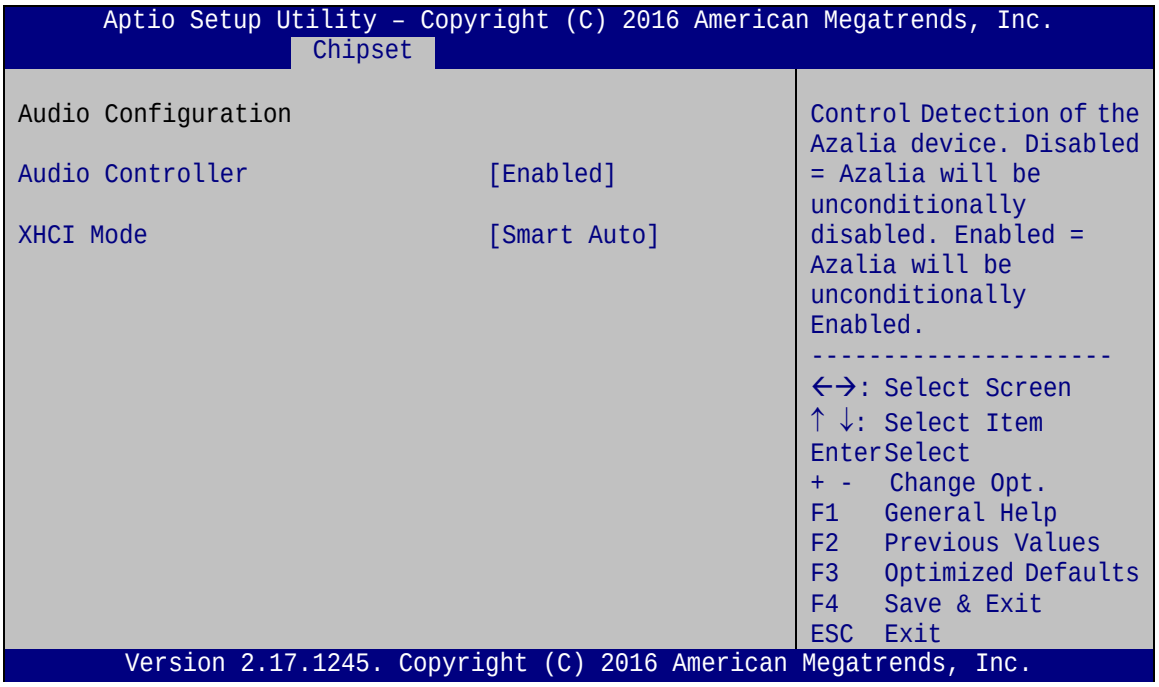
➔ **DVMT Total Gfx Mem [Max]**

Use the **DVMT Total Gfx Mem** option to specify the maximum amount of memory that can be allocated as graphics memory. Configuration options are listed below.

- 128MB
- 256MB
- Max **Default**

4.4.2 South Bridge Configuration

Use the **South Bridge** menu (**BIOS Menu 15**) to configure the audio device connected to the system.



BIOS Menu 15: South Bridge

➔ **Audio Controller [Enabled]**

Use the **Audio Controller** option to enable or disable the High Definition Audio controller.

➔ **Disabled** The onboard High Definition Audio controller is disabled

➔ **Enabled** **DEFAULT** The onboard High Definition Audio controller automatically detected and enabled

➔ **XHCI Mode [Smart Auto]**

Use the **XHCI Mode** BIOS option to configure the USB xHCI (USB 3.0) controller.

➔ **Enabled** Enable the xHCI controller. USB 3.0 ports behave as USB 3.0 ports.

➔ **Smart Auto** **DEFAULT** Allow the use of USB 3.0 devices prior to OS boot. USB 3.0 ports function as USB 3.0 ports even during a reboot.

4.5 Security

Use the **Security** menu (**BIOS Menu 16**) to set system and user passwords.

```
      Aptio Setup Utility – Copyright (C) 2016 American Megatrends, Inc.
  Main    Advanced   Chipset   Security    Boot    Save & Exit

Password Description                          Set Administrator
                                              Password
If ONLY the Administrator's password is set,
then this only limits access to Setup and is
only asked for when entering Setup.
If ONLY the User's password is set, then this ---------------------
is a power on password and must be entered to
boot or enter Setup. In Setup the User will   →←: Select Screen
have Administrator rights.                    ↑ ↓: Select Item
The password length must be                   Enter: Select
in the following range:                       +/-:  Change Opt.
Minimum length                    3           F1:  General Help
Maximum length                    20          F2:  Previous Values
                                              F3:  Optimized Defaults
Administrator Password                        F4:  Save & Exit
User Password                                 ESC: Exit

       Version 2.17.1245. Copyright (C) 2016 American Megatrends, Inc.
```

BIOS Menu 16: Security

➔ **Administrator Password**

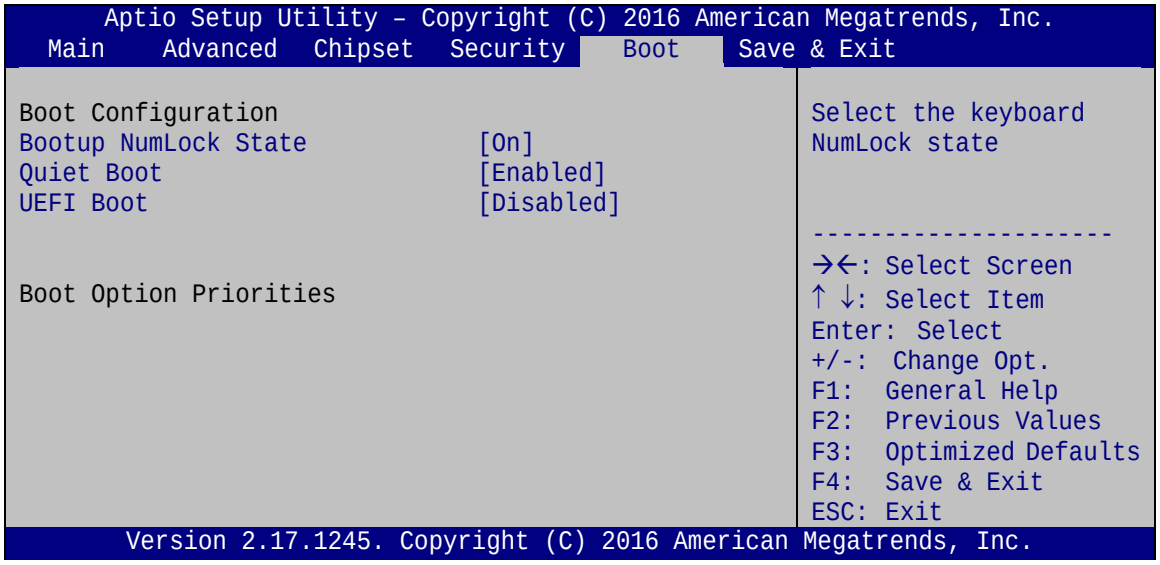
Use the **Administrator Password** to set or change an administrator password.

➔ **User Password**

Use the **User Password** to set or change a user password.

4.6 Boot

Use the **Boot** menu (**BIOS Menu 17**) to configure system boot options.



BIOS Menu 17: Boot

➔ **Bootup NumLock State [On]**

Use the **Bootup NumLock State** BIOS option to specify if the number lock setting must be modified during boot up.

➔ **On** **DEFAULT** Allows the Number Lock on the keyboard to be enabled automatically when the computer system boots up. This allows the immediate use of the 10-key numeric keypad located on the right side of the keyboard. To confirm this, the Number Lock LED light on the keyboard is lit.

➔ **Off** Does not enable the keyboard Number Lock automatically. To use the 10-keys on the keyboard, press the Number Lock key located on the upper left-hand corner of the 10-key pad. The Number Lock LED on the keyboard lights up when the Number Lock is engaged.

➔ **Quiet Boot [Enabled]**

Use the **Quiet Boot** BIOS option to select the screen display when the system boots.

➔ **Disabled** Normal POST messages displayed

➔ **Enabled** **DEFAULT** OEM Logo displayed instead of POST messages

➔ **UEFI Boot [Disabled]**

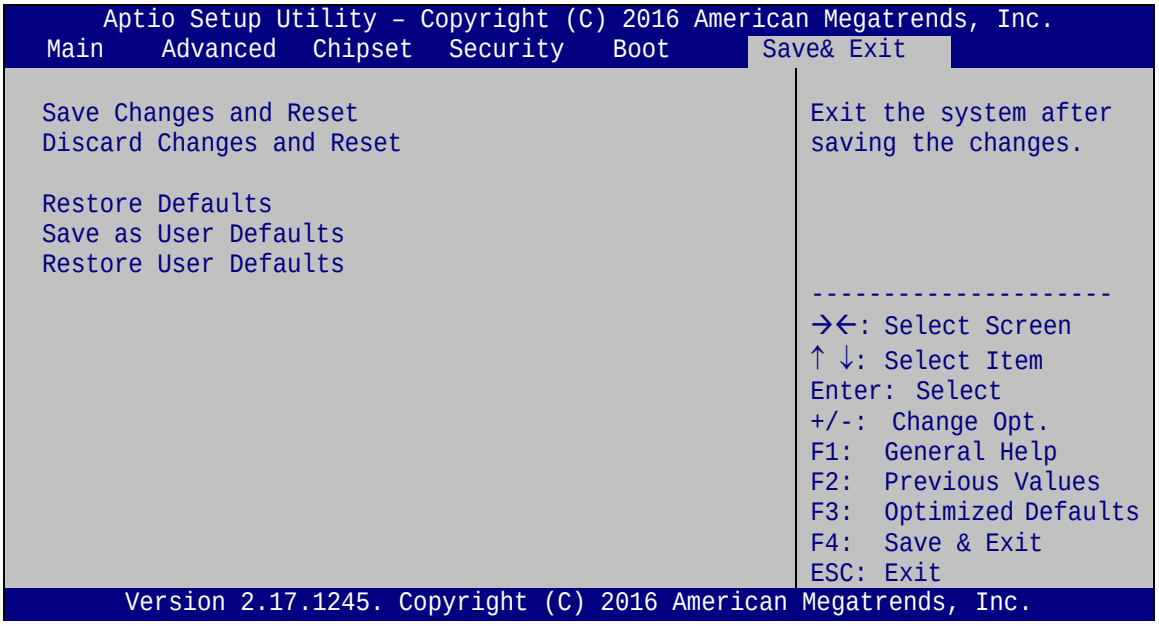
Use the **UEFI Boot** option to enable or disable to boot from the UEFI devices.

➔ **Enabled** Boot from UEFI devices is enabled.

➔ **Disabled** **DEFAULT** Boot from UEFI devices is disabled.

4.7 Save & Exit

Use the **Save & Exit** menu (**BIOS Menu 18**) to load default BIOS values, optimal failsafe values and to save configuration changes.



BIOS Menu 18: Save & Exit

➔ **Save Changes and Reset**

Use the **Save Changes and Reset** option to save the changes made to the BIOS options and reset the system.

➔ **Discard Changes and Reset**

Use the **Discard Changes and Reset** option to exit the system without saving the changes made to the BIOS configuration setup program.

➔ **Restore Defaults**

Use the **Restore Defaults** option to load the optimal default values for each of the parameters on the Setup menus. **F3 key can be used for this operation.**

➔ **Save as User Defaults**

Use the **Save as User Defaults** option to save the changes done so far as user defaults.

➔ **Restore User Defaults**

Use the **Restore User Defaults** option to restore the user defaults to all the setup options.

Chapter

5

Troubleshooting and Maintenance

WARNING:

Take Anti-Static precautions whenever maintenance is being carried out on the system components. Failure to take anti-static precautions can cause permanent system damage. For more details on anti-static precautions, please refer to **Section 3.1**.

5.1 IVS-300 System Maintenance Overview

NOTE:

When doing maintenance operations on the system, please follow the instructions in this chapter. Failure to follow these instructions may lead to personal injury and system damage.

To preserve the working integrity of the IVS-300 embedded system, the system must be properly maintained. If embedded system components need replacement, the proper maintenance procedures must be followed to ensure the system can continue to operate normally.

5.2 System Troubleshooting

This section provides some simple troubleshooting suggestions.

5.2.1 The System Doesn't Turn On

If after turning the system on, there is no power (indicated by the power LED on the front panel not turning on) please do the following:

Step 1: Check that the power cable connector is properly connected to the system rear panel.

Step 2: Check that the power cable connector is properly plugged into the power source.

Step 3: Make sure the power button is turned on.

Step 4: Plug the system into a monitor and check to see if anything appears on the screen. If the boot-up screen appears it means the power LED has failed. To fix this problem, contact an IEI sales representative directly.

5.2.2 The System Doesn't Boot Up

If the system doesn't boot up please do the following:

Step 1: Check the power is turned on. See Section 5.2.1 above.

Step 2: Make sure the SO-DIMM modules are properly installed.

5.2.3 More Troubleshooting

Nothing appears on the monitor after booting up the system: Make sure the monitor is properly connected to the system and the monitor is connected to a power supply and turned on.

WARNING!

If all troubleshooting measures have been taken and the system still fails to start, contact the IEI reseller or vendor you purchased the IVS-300 from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to sales@ieiworld.com.

5.3 Component Replacement Procedure

WARNING!

Users are not advised to attempt to repair or replace any internal or external components of the IVS-300 embedded system other than those listed below. If any other components fail or need replacement, contact the IEI reseller or vendor you purchased the IVS-300 from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to sales@ieiworld.com.

The embedded system components listed below can all be replaced if they fail:

- SO-DIMM module
- PCIe Mini card (see **Section 3.5**)
- WLAN or WWAN module (see **Section 3.5.1**)

5.3.1 SO-DIMM Replacement

WARNING:

Using incorrectly specified SO-DIMM may cause permanently damage the IVS-300. Please make sure the purchased SO-DIMM complies with the memory specifications of the IVS-300.

To replace a SO-DIMM memory module into a SO-DIMM socket, please follow the steps below.

Step 1: Access the front side of the main board. See Section 3.4.

Step 2: Locate the SO-DIMMs on the motherboard.

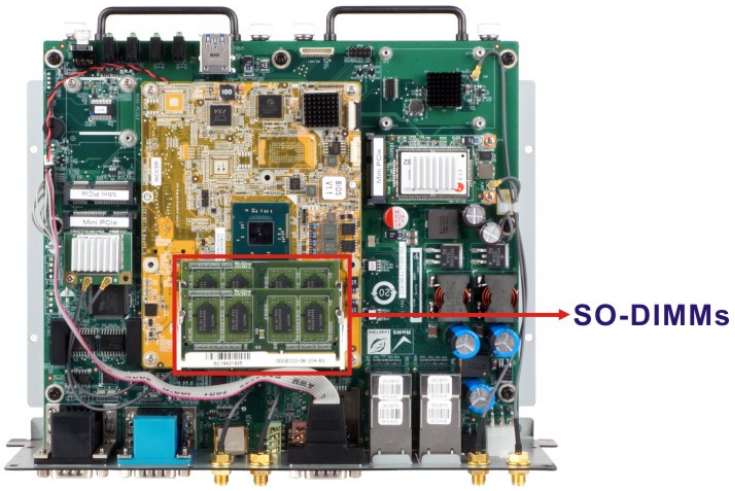


Figure 5-1: SO-DIMM Locations

Step 3: Remove the SO-DIMM by releasing the arms on the SO-DIMM socket.

Step 4: Align the new SO-DIMM with the socket. The SO-DIMM must be oriented in such a way that the notch in the middle of the SO-DIMM must be aligned with the plastic bridge in the socket (**Figure 5-2**).

Step 5: Insert the SO-DIMM. Push the SO-DIMM chip into the socket at an angle (**Figure 5-2**).

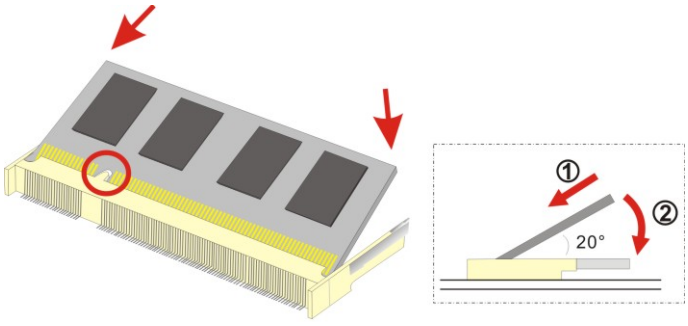


Figure 5-2: SO-DIMM Installation

Step 6: Open the SO-DIMM socket arms. Gently pull the arms of the SO-DIMM socket out and push the rear of the SO-DIMM down (See **Figure 5-2**).

Step 7: Secure the SO-DIMM. Release the arms on the SO-DIMM socket. They clip into place and secure the SO-DIMM in the socket.

Appendix

A

Regulatory Compliance

DECLARATION OF CONFORMITY

CE

This equipment is in conformity with the following EU directives:

- EMC Directive (2004/108/EC, 2014/30/EU)
- Low-Voltage Directive (2006/95/EC, 2014/35/EU)
- RoHS II Directive (2011/65/EU, 2015/863/EU)

If the user modifies and/or install other devices in the equipment, the CE conformity declaration may no longer apply.

If this equipment has telecommunications functionality, it also complies with the requirements of the Radio Equipment Directive 2014/53/EU.

English IEI Integration Corp declares that this equipment is in compliance with the essential requirements and other relevant provisions of Directive 2014/53/EU.
Български [Bulgarian] IEI Integration Corp. декларира, че този оборудване е в съответствие със съществените изисквания и другите приложими правила на Директива 2014/53/EU.
Česky [Czech] IEI Integration Corp tímto prohlašuje, že tento zařízení je ve shodě se základními požadavky a dalšími příslušnými ustanoveními směrnice 2014/53/EU.
Dansk [Danish] IEI Integration Corp erklærer herved, at følgende udstyr overholder de væsentlige krav c øvrige relevante krav i direktiv 2014/53/EU.
Deutsch [German] IEI Integration Corp, erklärt dieses Gerät entspricht den grundlegenden Anforderungen und den weiteren entsprechenden Vorgaben der Richtlinie 2014/53/EU.
Eesti [Estonian] IEI Integration Corp deklareerib seadme seadme vastavust direktiivi 2014/53/EÜ põhinõuetele ja nimetatud direktiivist tulenevatele teistele asjakohastele sätetele.

Español [Spanish] IEI Integration Corp declara que el equipo cumple con los requisitos esenciales y cualesquiera otras disposiciones aplicables o exigibles de la Directiva 2014/53/EU.
Ελληνική [Greek] IEI Integration Corp ΔΗΛΩΝΕΙ ΟΤΙ ΕΞΟΠΛΙΣΜΟΣ ΣΥΜΜΟΡΦΩΝΕΤΑΙ ΠΡΟΣ ΤΙΣ ΟΥΣΙΩΔΕΙΣ ΑΠΑΙΤΗΣΕΙΣ ΚΑΙ ΤΙΣ ΛΟΙΠΕΣ ΣΧΕΤΙΚΕΣ ΔΙΑΤΑΞΕΙΣ ΤΗΣ ΟΔΗΓΙΑΣ 2014/53/EU.
Français [French] IEI Integration Corp déclare que l'appareil est conforme aux exigences essentielles et aux autres dispositions pertinentes de la directive 2014/53/EU.
Italiano [Italian] IEI Integration Corp dichiara che questo apparecchio è conforme ai requisiti essenziali ed alle altre disposizioni pertinenti stabilite dalla direttiva 2014/53/EU.
Latviski [Latvian] IEI Integration Corp deklarē, ka iekārta atbilst būtiskajām prasībām un citiem ar to saistītajiem noteikumiem Direktīvas 2014/53/EU.
Lietuvių [Lithuanian] IEI Integration Corp deklaruoja, kad šis įranga atitinka esminius reikalavimus ir kitas 2014/53/EU Direktyvos nuostatas.
Nederlands [Dutch] IEI Integration Corp dat het toestel toestel in overeenstemming is met de essentiële eisen en de andere relevante bepalingen van richtlijn 2014/53/EU.
Malti [Maltese] IEI Integration Corp jiddikjara li dan prodott jikkonforma mal-ħtiġijiet essenzjali u ma provvedimenti oħrajn relevanti li hemm fid-Dirrettiva 2014/53/EU.
Magyar [Hungarian] IEI Integration Corp nyilatkozom, hogy a berendezés megfelel a vonatkozó alapvetõ követelményeknek és az 2014/53/EU irányelv egyéb elõírásainak.
Polski [Polish] IEI Integration Corp oświadcza, że wyrobu jest zgodny z zasadniczymi wymogami oraz pozostałym□stosownymi postanowieniami Dyrektywy 2014/53/EU.
Português [Portuguese] IEI Integration Corp declara que este equipamento está conforme com os requisitos essenciais e outras disposições da Directiva 2014/5□/EU.

Româna [Romanian] IEI Integration Corp declară că acest echipament este in conformitate cu cerinţele esenţiale şi cu celelalte prevederi relevante ale Directivei 2014/53/EU.
Slovensko [Slovenian] IEI Integration Corp izjavlja, da je ta opreme v skladu z bistvenimi zahtevami in ostalimi relevantnimi določili direktive 2014/53/EU.
Slovensky [Slovak] IEI Integration Corp týmto vyhlasuje, že zariadenia spĺňa základné požiadavky a všetky príslušné ustanovenia Smernice 2014/53/EU.
Suomi [Finnish] IE□Integration Corp vakuuttaa täten että laitteet on direktiivin 2014/53/EU oleellisten vaatimusten ja sitä koskevien direktiivin muiden ehtojen mukainen.
Svenska [Swedish] IEI Integration Corp förklarar att denna utrustningstyp står I överensstämmelse med de väsentliga egenskapskrav och övriga relevanta bestämmelser som framgår av direktiv 2014/53/EU.

FCC WARNING

This equipment complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- This device may not cause harmful interference, and
- This device must accept any interference received, including interference that may cause undesired operation.

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

Federal Communication Commission Interference Statement

This equipment has been assembled with components that comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Appendix

B

Safety Precautions

WARNING:

The precautions outlined in this chapter should be strictly followed. Failure to follow these precautions may result in permanent damage to the IVS-300.

B.1 Safety Precautions

Please follow the safety precautions outlined in the sections that follow:

B.1.1 General Safety Precautions

Please ensure the following safety precautions are adhered to at all times.

- ***Follow the electrostatic precautions*** outlined below whenever the device is opened.
- ***Make sure the power is turned off and the power cord is disconnected*** whenever the IVS-300 is being installed, moved or modified.
- ***To prevent the risk of electric shock, make sure power cord is unplugged from wall socket.*** To fully disengage the power to the unit, please disconnect the power cord from the power outlet. Refer servicing to qualified service personnel. The power outlet shall be readily available and accessible.
- ***Do not apply voltage levels that exceed the specified voltage range***. Doing so may cause fire and/or an electrical shock. Use a power cord that matches the voltage of the power outlet, which has been approved and complies with the safety standard of your particular country.
- ***Electric shocks can occur*** if the IVS-300 chassis is opened when it is running. To avoid risk of electric shock, this device must only be connected to a supply mains with protective earth.
- ***Do not drop or insert any objects*** into the ventilation openings of the IVS-300.

- ***If considerable amounts of dust, water, or fluids enter the* device**, turn off the power supply immediately, unplug the power cord, and contact the IVS-300 vendor.
- **DO NOT**:
  - Drop the device against a hard surface.
  - In a site where the ambient temperature exceeds the rated temperature

B.1.2 Anti-static Precautions

WARNING:

Failure to take ESD precautions during the installation of the IVS-300 may result in permanent damage to the IVS-300 and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the IVS-300. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the IVS-300 is opened and any of the electrical components are handled, the following anti-static precautions are strictly adhered to.

- ***Wear an anti-static wristband***: Wearing a simple anti-static wristband can help to prevent ESD from damaging any electrical component.
- ***Self-grounding***: Before handling any electrical component, touch any grounded conducting material. During the time the electrical component is handled, frequently touch any conducting materials that are connected to the ground.
- ***Use an anti-static pad***: When configuring or working with an electrical component, place it on an anti-static pad. This reduces the possibility of ESD damage.
- ***Only handle the edges of the electrical component***: When handling the electrical component, hold the electrical component by its edges.

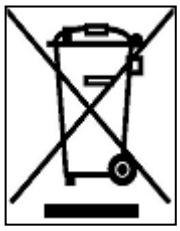
B.1.3 Product Disposal

CAUTION:

Risk of explosion if battery is replaced by an incorrect type. Only certified engineers should replace the on-board battery.

Dispose of used batteries according to instructions and local regulations.

- Outside the European Union – If you wish to dispose of used electrical and electronic products outside the European Union, please contact your local authority so as to comply with the correct disposal method.
- Within the European Union – The device that produces less waste and is easier to recycle is classified as electronic device in terms of the European Directive 2012/19/EU (WEEE), and must not be disposed of as domestic garbage.



EU-wide legislation, as implemented in each Member State, requires that waste electrical and electronic products carrying the mark (left) must be disposed of separately from normal household waste. This includes monitors and electrical accessories, such as signal cables or power cords. When you need to dispose of your display products, please follow the guidance of your local authority, or ask the shop where you purchased the product. The mark on electrical and electronic products only applies to the current European Union Member States.

Please follow the national guidelines for electrical and electronic product disposal.

B.2 Maintenance and Cleaning Precautions

When maintaining or cleaning the IVS-300, please follow the guidelines below.

WARNING:

- For safety reasons, turn-off the power and unplug the embedded system before cleaning.
- If you dropped any material or liquid such as water onto the embedded system when cleaning, unplug the power cable immediately and contact your dealer or the nearest service center. Always make sure your hands are dry when unplugging the power cable.

B.2.1 Maintenance and Cleaning

Prior to cleaning any part or component of the IVS-300, please read the details below.

- Never spray or squirt liquids directly onto any other components. To clean the embedded system, gently wipe it with a piece of soft dry cloth or a slightly moistened cloth.
- The interior of the device does not require cleaning. Keep fluids away from the device interior.
- Be cautious of all small removable components when vacuuming the device.
- Never drop any objects or liquids through the openings of the device.
- Be cautious of any possible allergic reactions to solvents or chemicals used when cleaning the device.
- Avoid eating, drinking and smoking within vicinity of the device.

B.2.2 Cleaning Tools

Some components in the IVS-300 may only be cleaned using a product specifically designed for the purpose. In such case, the product will be explicitly mentioned in the cleaning tips. Below is a list of items to use when cleaning the IVS-300.

- ***Cloth*** – Although paper towels or tissues can be used, a soft, clean piece of cloth is recommended when cleaning the device.

- ***Water or rubbing alcohol*** – A cloth moistened with water or rubbing alcohol can be used to clean the device.
- ***Using solvents*** – The use of solvents is not recommended when cleaning the device as they may damage the plastic parts.
- ***Vacuum cleaner*** – Using a vacuum specifically designed for computers is one of the best methods of cleaning the device. Dust and dirt can restrict the airflow in the device and cause its circuitry to corrode.
- ***Cotton swabs*** – Cotton swaps moistened with rubbing alcohol or water are excellent tools for wiping hard to reach areas.
- **Foam swabs** – Whenever possible, it is best to use lint free swabs such as foam swabs for cleaning.

Appendix

C

BIOS Menu Options

C.1 BIOS Configuration Options

Below is a list of BIOS configuration options described in **Chapter 4**.

Appendix

D

Watchdog Timer

NOTE:

The following discussion applies to DOS environment. IEI support is contacted or the IEI website visited for specific drivers for more sophisticated operating systems, e.g., Windows and Linux.

The Watchdog Timer is provided to ensure that standalone systems can always recover from catastrophic conditions that cause the CPU to crash. This condition may have occurred by external EMI or a software bug. When the CPU stops working correctly, Watchdog Timer either performs a hardware reset (cold boot) or a Non-Maskable Interrupt (NMI) to bring the system back to a known state.

A BIOS function call (INT 15H) is used to control the Watchdog Timer:

INT 15H:

AH – 6FH Sub-function:	
AL – 2:	Sets the Watchdog Timer's period.
BL:	Time-out value (Its unit-second is dependent on the item "Watchdog Timer unit select" in CMOS setup).

Table D-1: AH-6FH Sub-function

Call sub-function 2 to set the time-out period of Watchdog Timer first. If the time-out value is not zero, the Watchdog Timer starts counting down. While the timer value reaches zero, the system resets. To ensure that this reset condition does not occur, calling sub-function 2 must periodically refresh the Watchdog Timer. However, the Watchdog timer is disabled if the time-out value is set to zero.

A tolerance of at least 10% must be maintained to avoid unknown routines within the operating system (DOS), such as disk I/O that can be very time-consuming.

NOTE:

When exiting a program it is necessary to disable the Watchdog Timer, otherwise the system resets.

Example program:

```
; INITIAL TIMER PERIOD COUNTER
;
W_LOOP:

        MOV     AX, 6F02H       ;setting the time-out value
        MOV     BL, 30          ;time-out value is 48 seconds
        INT      15H
 ;
; ADD THE APPLICATION PROGRAM HERE
;
        CMP      EXIT_AP, 1     ;is the application over?
        JNE      W_LOOP         ;No, restart the application

        MOV     AX, 6F02H       ;disable Watchdog Timer
        MOV     BL, 0           ;
        INT      15H
;
; EXIT ;
```

Appendix

E

Hazardous Materials Disclosure

The details provided in this appendix are to ensure that the product is compliant with the Peoples Republic of China (China) RoHS standards. The table below acknowledges the presences of small quantities of certain materials in the product, and is applicable to China RoHS only.

A label will be placed on each product to indicate the estimated "Environmentally Friendly Use Period" (EFUP). This is an estimate of the number of years that these substances would "not leak out or undergo abrupt change." This product may contain replaceable sub-assemblies/components which have a shorter EFUP such as batteries and lamps. These components will be separately marked.

Please refer to the following table.

Part Name	Toxic or Hazardous Substances and Elements					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (CR(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)
Housing	O	O	O	O	O	O
Display	O	O	O	O	O	O
Printed Circuit Board	O	O	O	O	O	O
Metal Fasteners	O	O	O	O	O	O
Cable Assembly	O	O	O	O	O	O
Fan Assembly	O	O	O	O	O	O
Power Supply Assemblies	O	O	O	O	O	O
Battery	O	O	O	O	O	O

O: This toxic or hazardous substance is contained in all of the homogeneous materials for the part is below the limit requirement in SJ/T11363-2006 (now replaced by GB/T 26572-2011).

X: This toxic or hazardous substance is contained in at least one of the homogeneous materials for this part is above the limit requirement in SJ/T11363-2006 (now replaced by GB/T 26572-2011).

此附件旨在确保本产品符合中国 RoHS 标准。以下表格标示此产品中某有毒物质的含量符合中国 RoHS 标准规定的限量要求。

本产品上会附有"环境友好使用期限"的标签，此期限是估算这些物质"不会有泄漏或突变"的年限。本产品可能包含有较短的环境友好使用期限的可替换元件，像是电池或灯管，这些元件将会单独标示出来。

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (CR(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
壳体	O	O	O	O	O	O
显示	O	O	O	O	O	O
印刷电路板	O	O	O	O	O	O
金属螺帽	O	O	O	O	O	O
电缆组装	O	O	O	O	O	O
风扇组装	O	O	O	O	O	O
电力供应组装	O	O	O	O	O	O
电池	O	O	O	O	O	O

O: 表示该有毒有害物质在该部件所有物质材料中的含量均在 SJ/T 11363-2006 (现由 GB/T 26572-2011 取代) 标准规定的限量要求以下。

X: 表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 (现由 GB/T 26572-2011 取代) 标准规定的限量要求。